

# Renesas RX Family

## Azure RTOS TraceX for Azure RTOS ThreadX Debugging

### Introduction

Azure RTOS ThreadX is an RTOS from Microsoft Corporation and is based on a high-performance embedded kernel.

Azure RTOS TraceX is a Windows-based analysis tool for use with real-time operating systems. It provides embedded developers with a graphical view of real-time system events and enables them to visualize and better understand the behavior of their real-time systems.

This application note describes procedures for checking Azure RTOS ThreadX thread and object states (referred to as resources) during the development of applications in the e<sup>2</sup> studio. The procedure for installing and starting Azure RTOS ThreadX is also explained.

### Target Device

RX65N Group (R5F565NEHDFB)

### Operating Environment

Target Board	CK-RX65N
Integrated Development Environment (IDE)	e <sup>2</sup> studio version 2023-01
Compiler	CC-RX V3.04.00
Trace Tool	Microsoft Azure RTOS TraceX v6.1.12.0
OS	Microsoft Azure RTOS ThreadX v6.2.0

Note: Please download the installer for the IDE from the page at the URL linked below in advance.  
[e<sup>2</sup> studio -information for RX Family | Renesas](#)

This application note has been adapted for RX-support from the following application note.

[RA Family Azure RTOS TraceX for Azure RTOS ThreadX Debugging](#)

Refer also to the following documents.

- RX Smart Configurator User's Guide: e<sup>2</sup> studio site:  
[RX Smart Configurator User's Guide: e<sup>2</sup> studio](#)
- Azure RTOS ThreadX documents on the Microsoft site:  
[Azure RTOS ThreadX documentation | Microsoft Learn](#)  
[Azure RTOS TraceX documentation | Microsoft Learn](#)

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### 1. Installing the e<sup>2</sup> studio

Install the e<sup>2</sup> studio with reference to the videos related to procedures for installing the e<sup>2</sup> studio at links from the following URL.

[RX Family Software & Tool Course | Renesas](#)

### 2. Installing Azure RTOS TraceX

Download Azure RTOS TraceX from the following Microsoft Store Apps site and install it.

[Azure RTOS TraceX - Microsoft Store Apps](#)

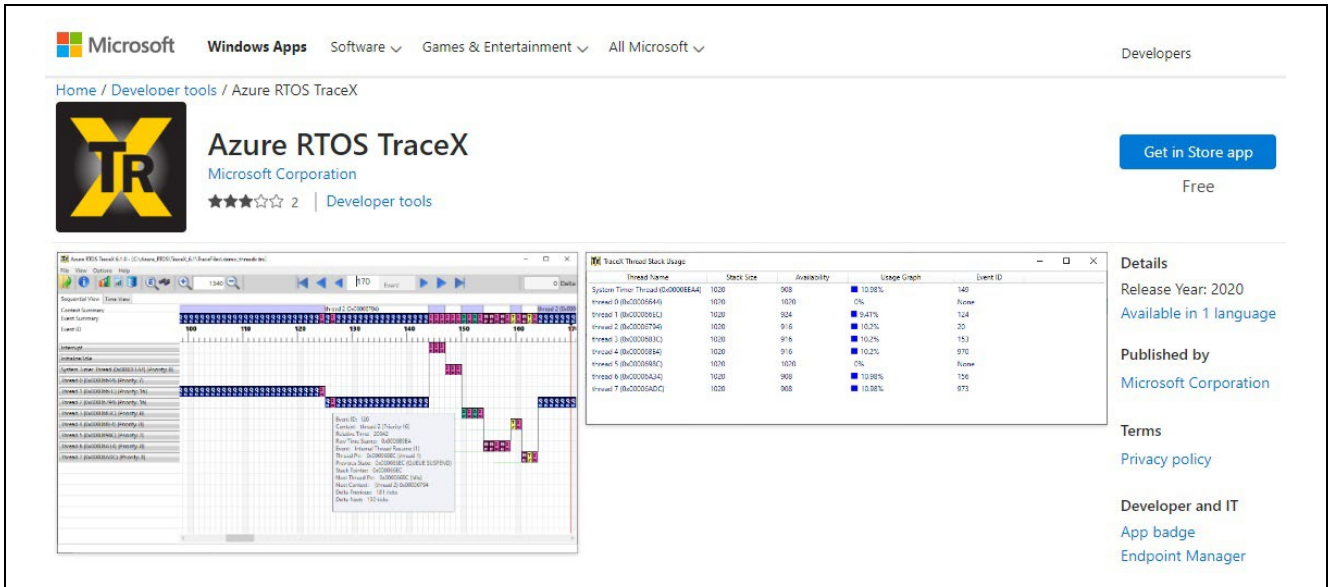


Figure 2-1 Microsoft Store Apps

### 3. Setting the CK-RX65N Board and Connection to the Host PC

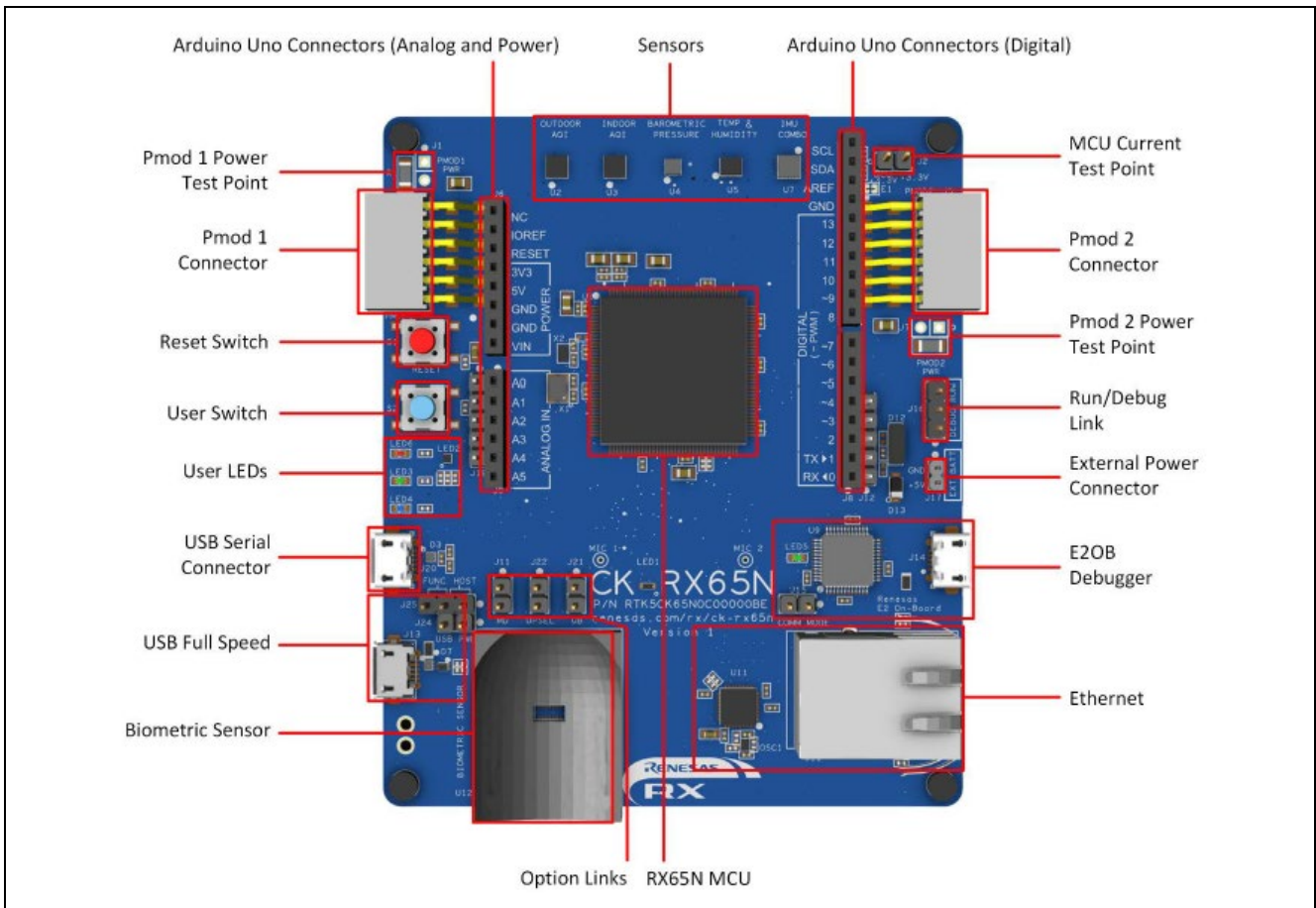


Figure 3-1 CK-RX65N Board

Make a jumper setting on the board and connect the board to the host PC with a USB cable as shown below.

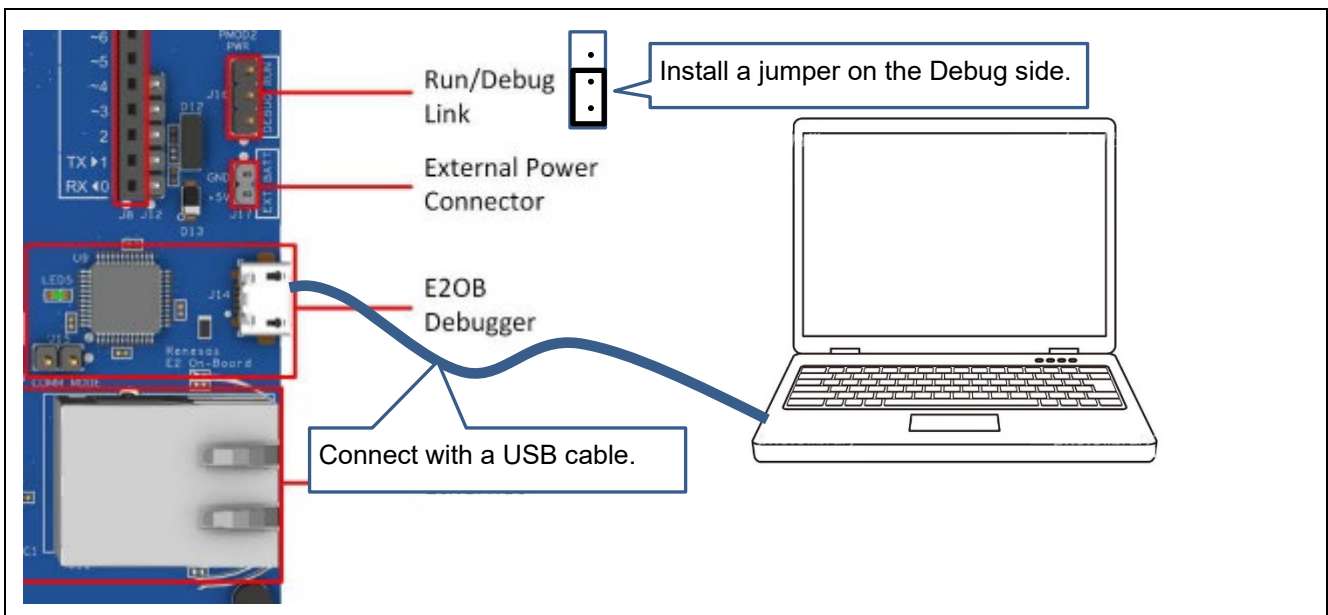


Figure 3-2 Jumper Setting and Connection between the CK-RX65N Board and the Host PC

## 4. Creating a ThreadX Project in the e<sup>2</sup> studio

Create a project by following the procedure below.

### 4.1 Procedure for Creating a Project

(1) Select the [File] menu → [New] → [Renesas C/C++ Project] → [Renesas RX].

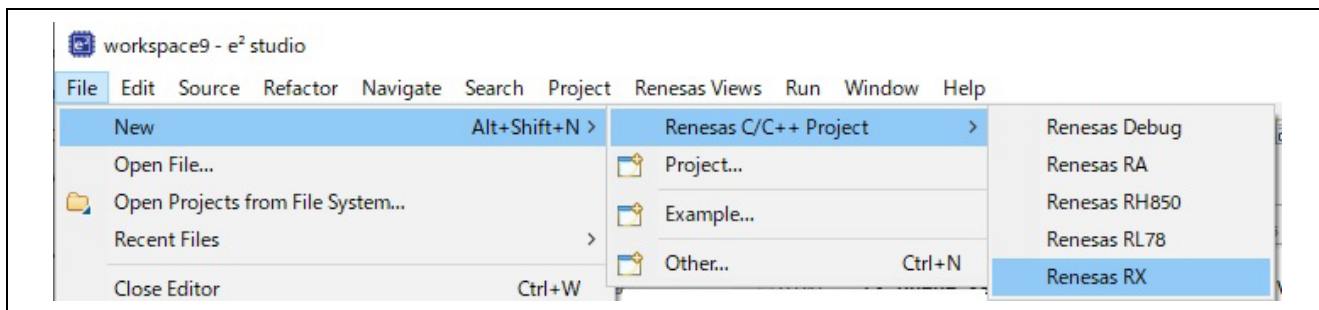


Figure 4-1 Selecting a Project Type and a Device Family

(2) Select the "Renesas CC-RX C/C++ Executable Project" template and click on [Next] to continue.

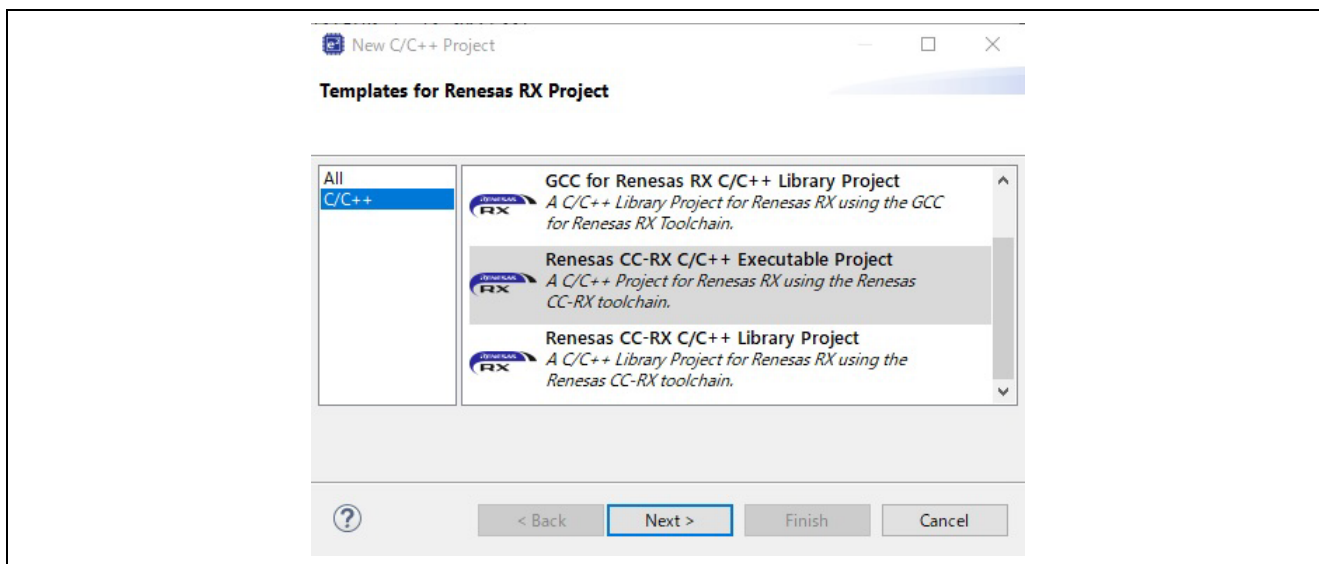


Figure 4-2 Selecting an Executable Project

(3) In the next dialog box, enter a project name and click on [Next].

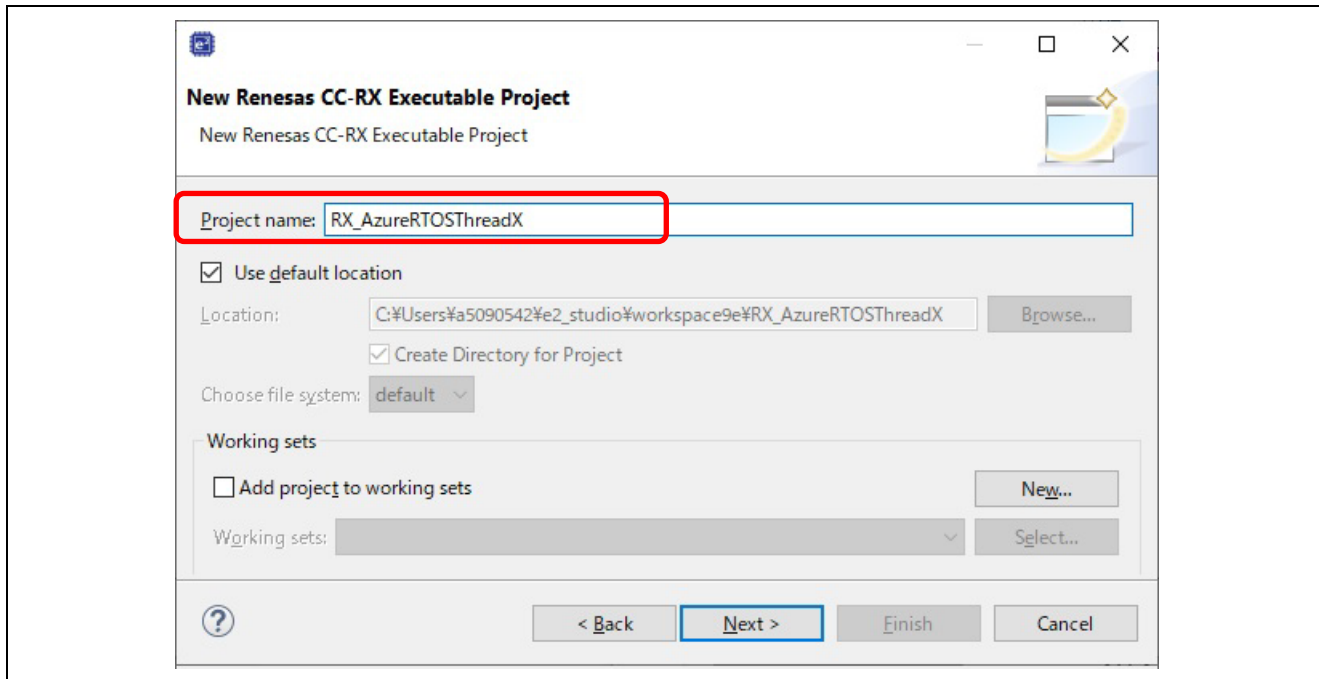


Figure 4-3 Entering a Project Name

(4) In the device selection dialog box, enter information on the device and tool.

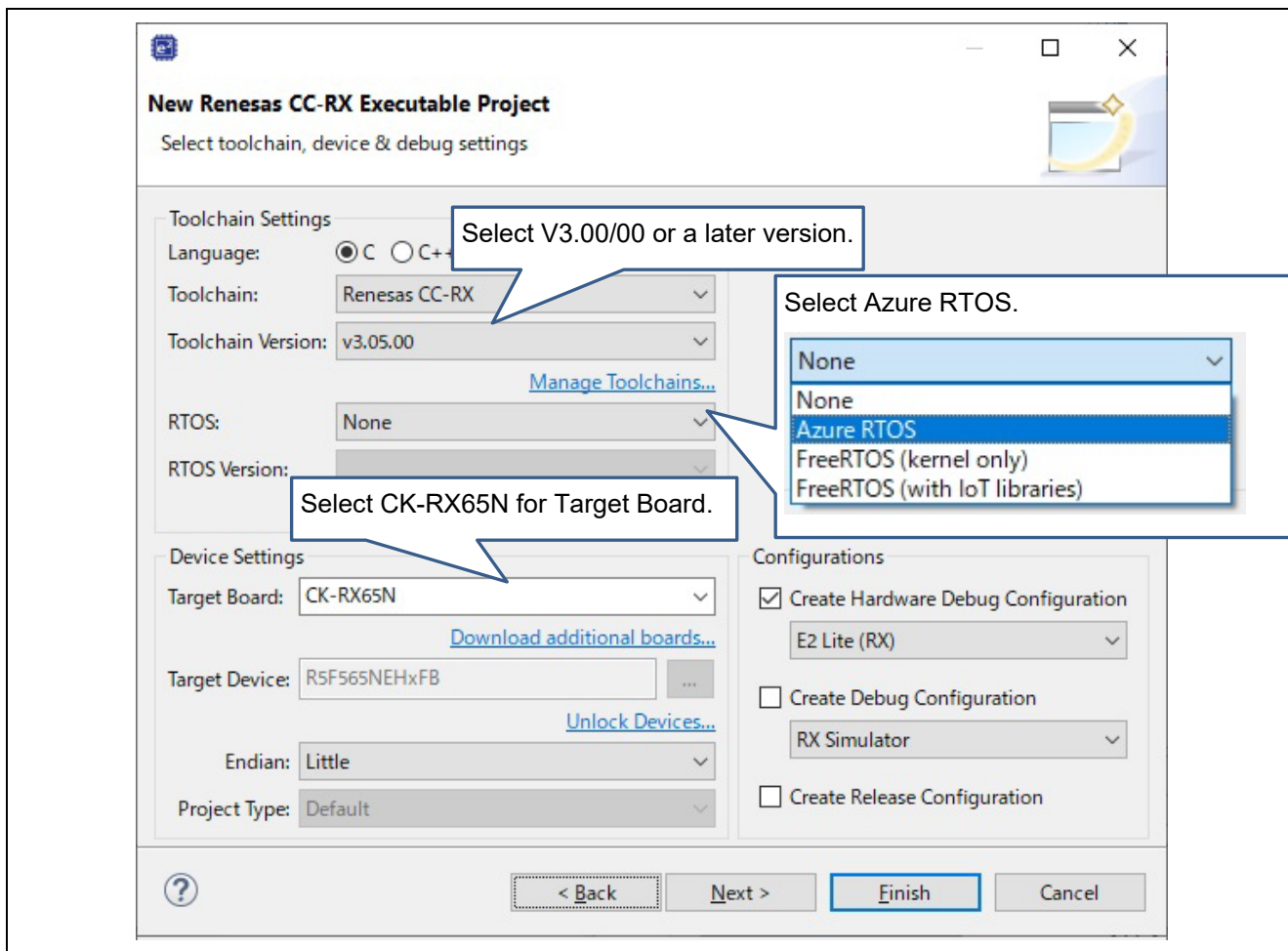


Figure 4-4 Selecting the Board and OS



(5) Use the default settings of the Smart Configurator.

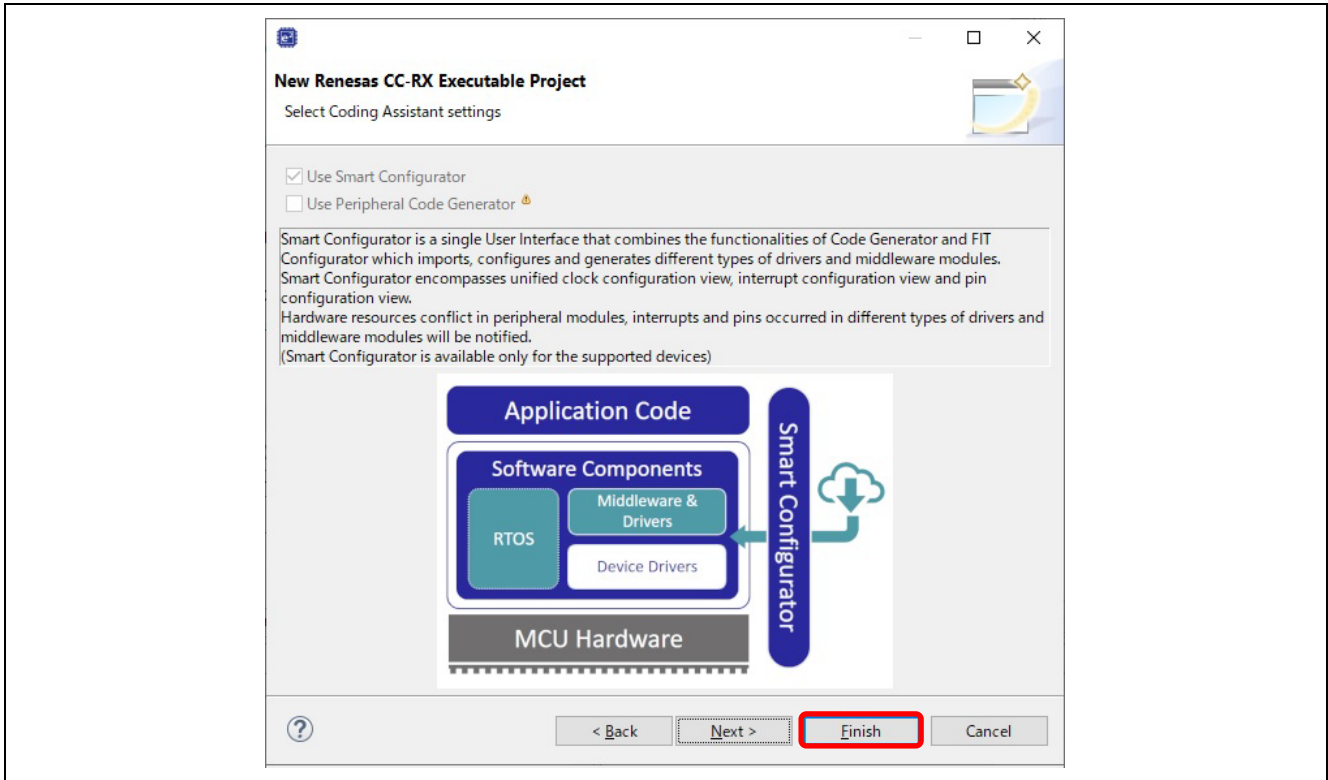


Figure 4-5 Smart Configurator Settings

(6) Select "ThreadX sample project".

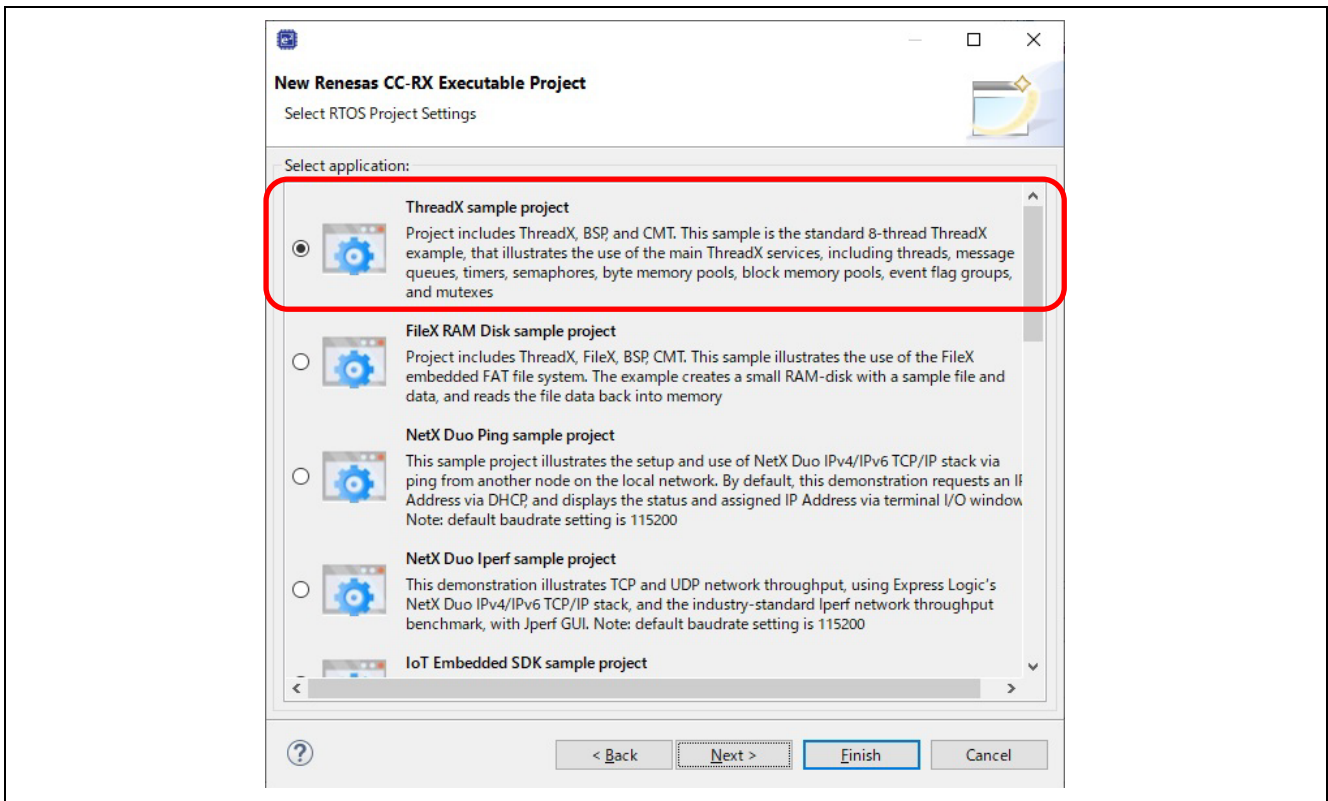


Figure 4-6 Selecting "ThreadX sample project"

(7) Click on [Finish] to complete project creation.

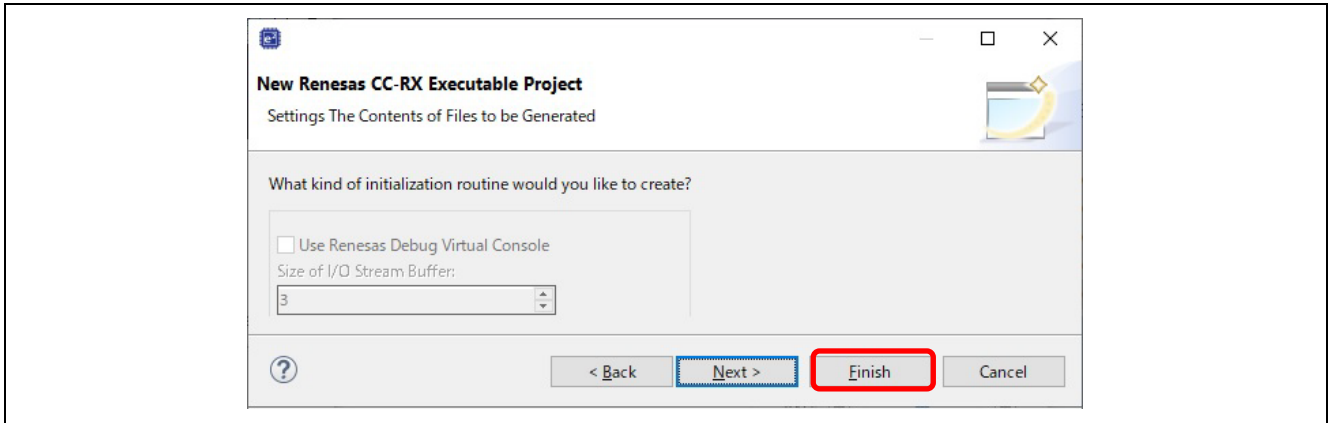


Figure 4-7 Completing Project Creation

(8) Select the current text editor.

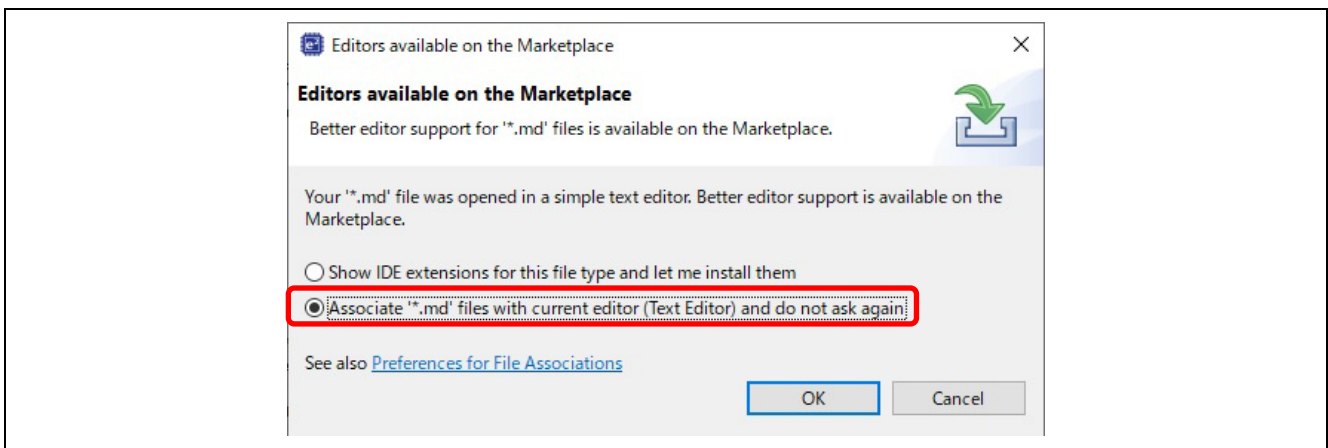


Figure 4-8 Selecting a Text Editor



### 4.2 Downloading a Component

Click on "RX\_AzureRTOSThreadX.cfg" to open the [Software component configuration] panel.

If the icon for "r\_cmt\_rx" is gray, the component is disabled. Download it as follows.

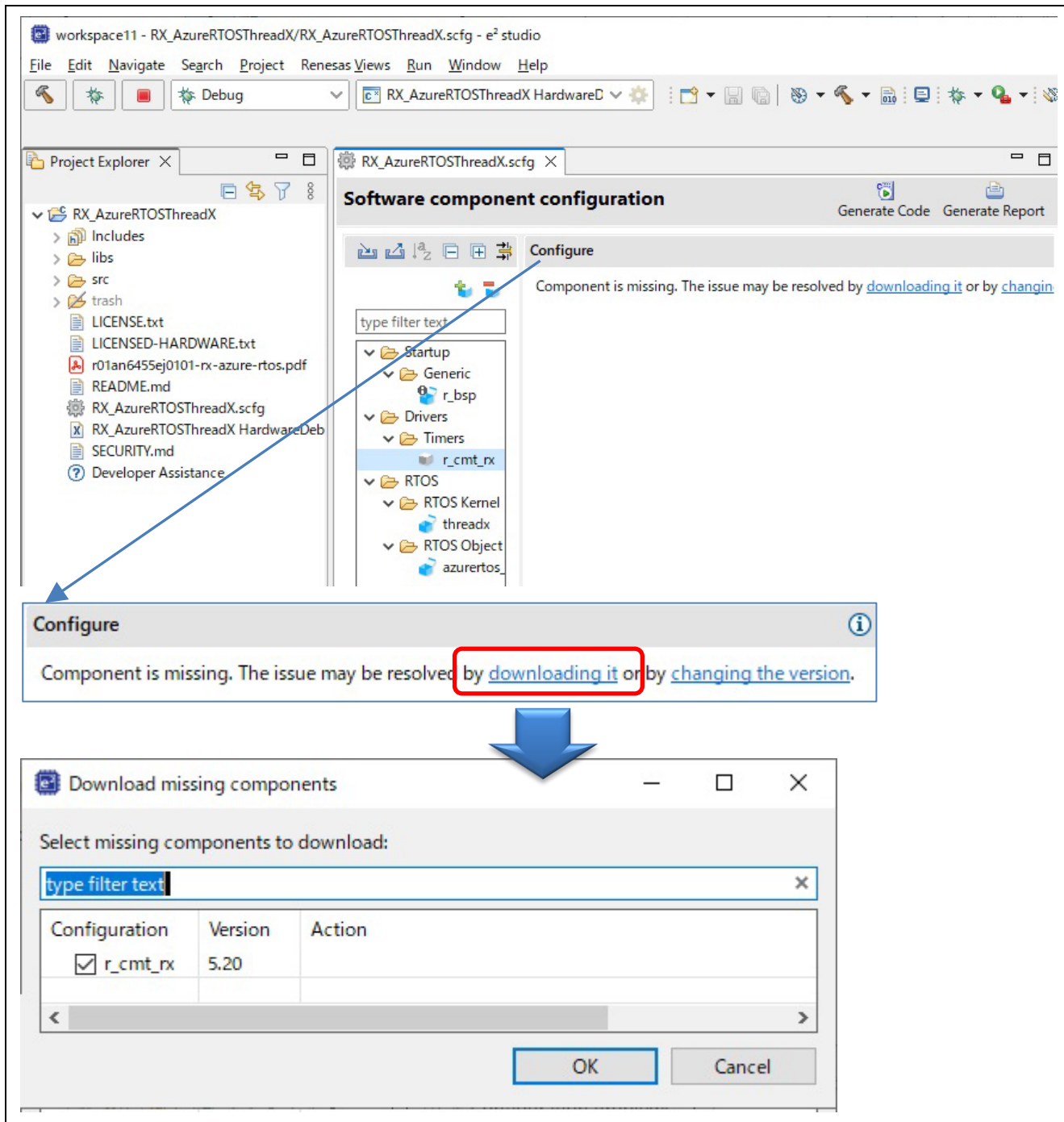


Figure 4-9 Downloading a Component

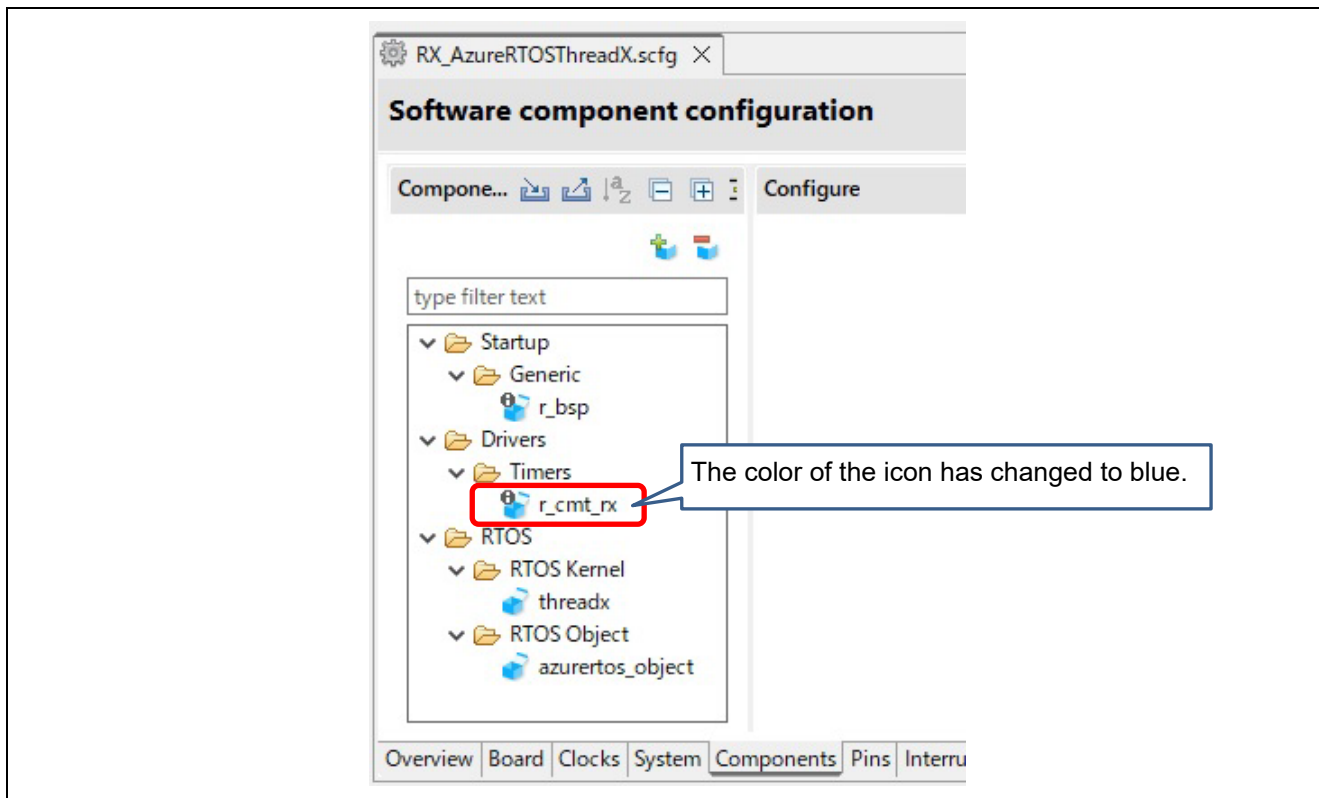


Figure 4-10 Component after Updating

Check the versions of the components on the [Overview] tabbed page.

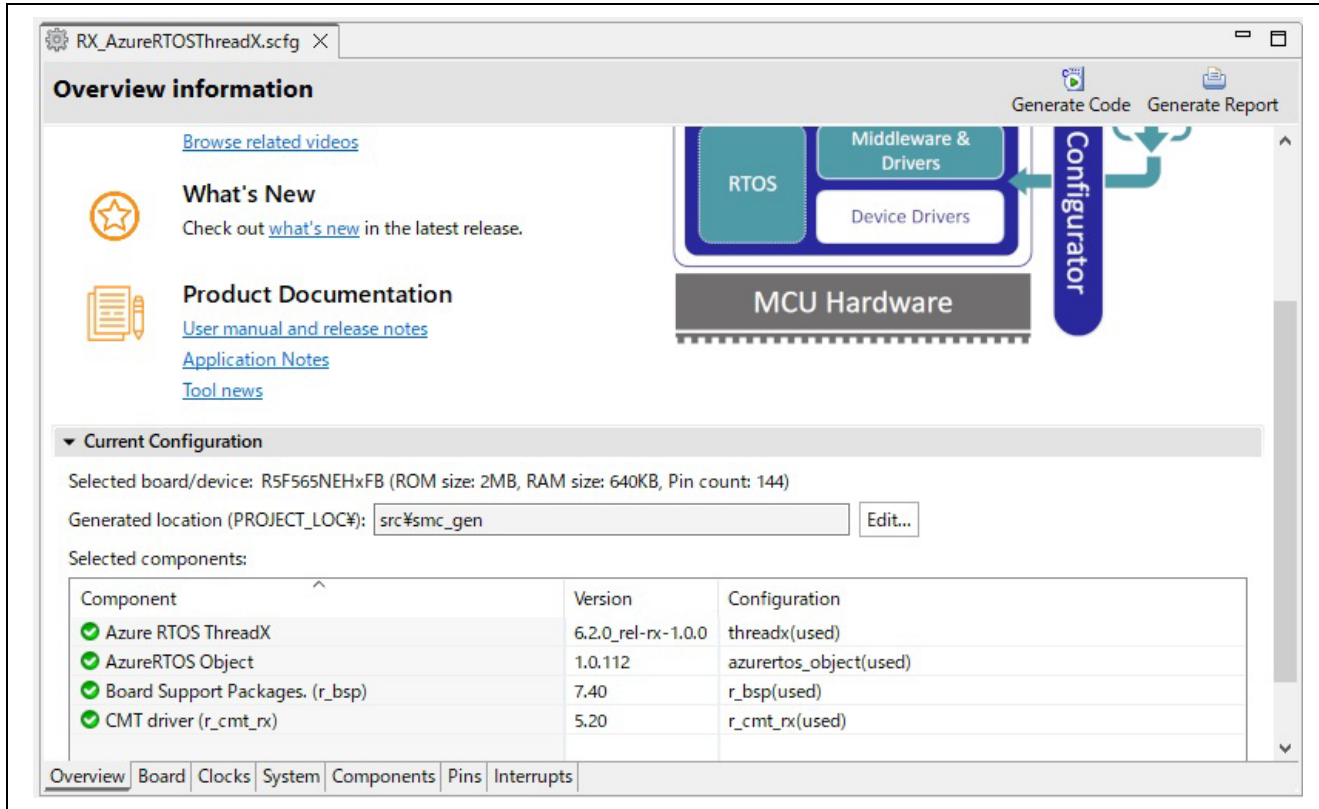


Figure 4-11 Checking the Versions of the Components Used

### 4.3 Configuring Components

- (1) Enable the trace events shown in the figure below under [Property] in the [Configure] panel for the ThreadX component.

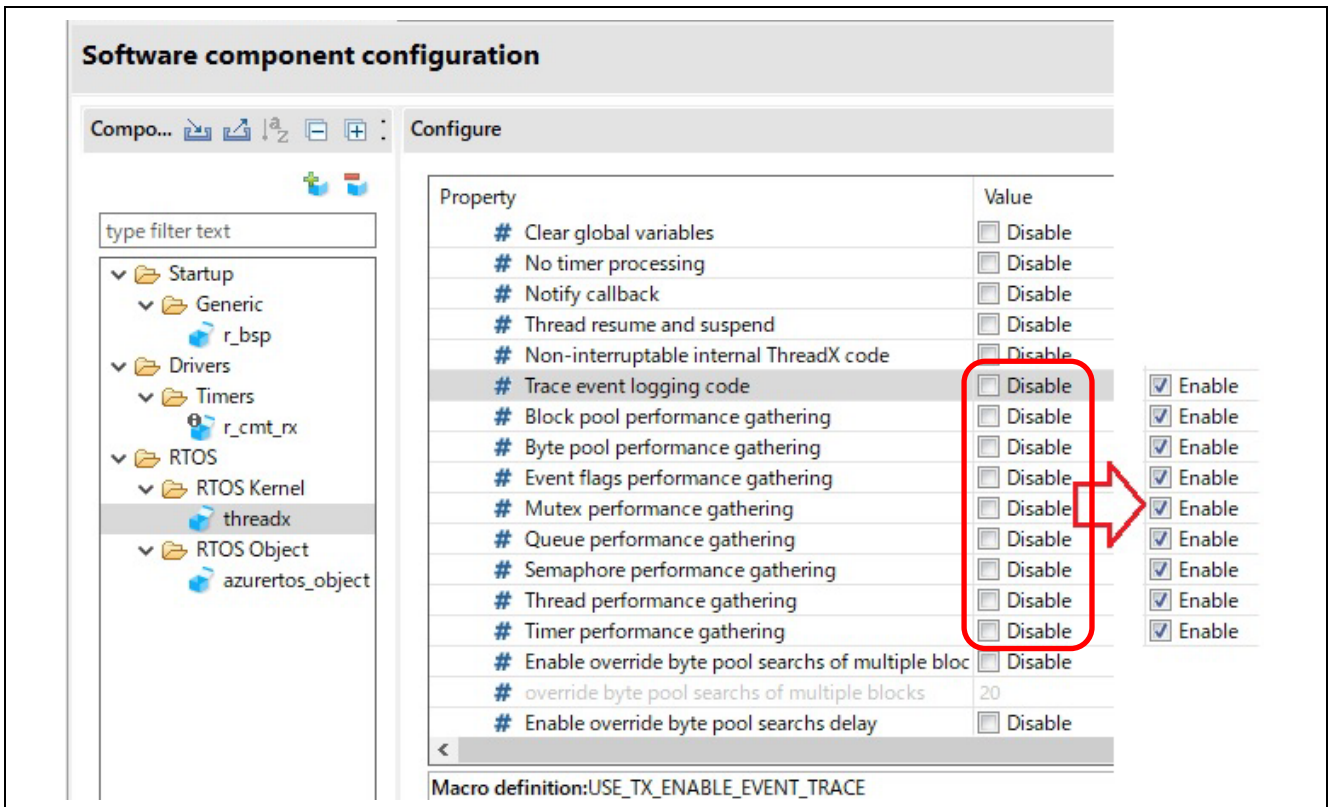


Figure 4-12 Setting ThreadX Properties

(2) Open the [Software Component Selection] dialog box and add "Ports".

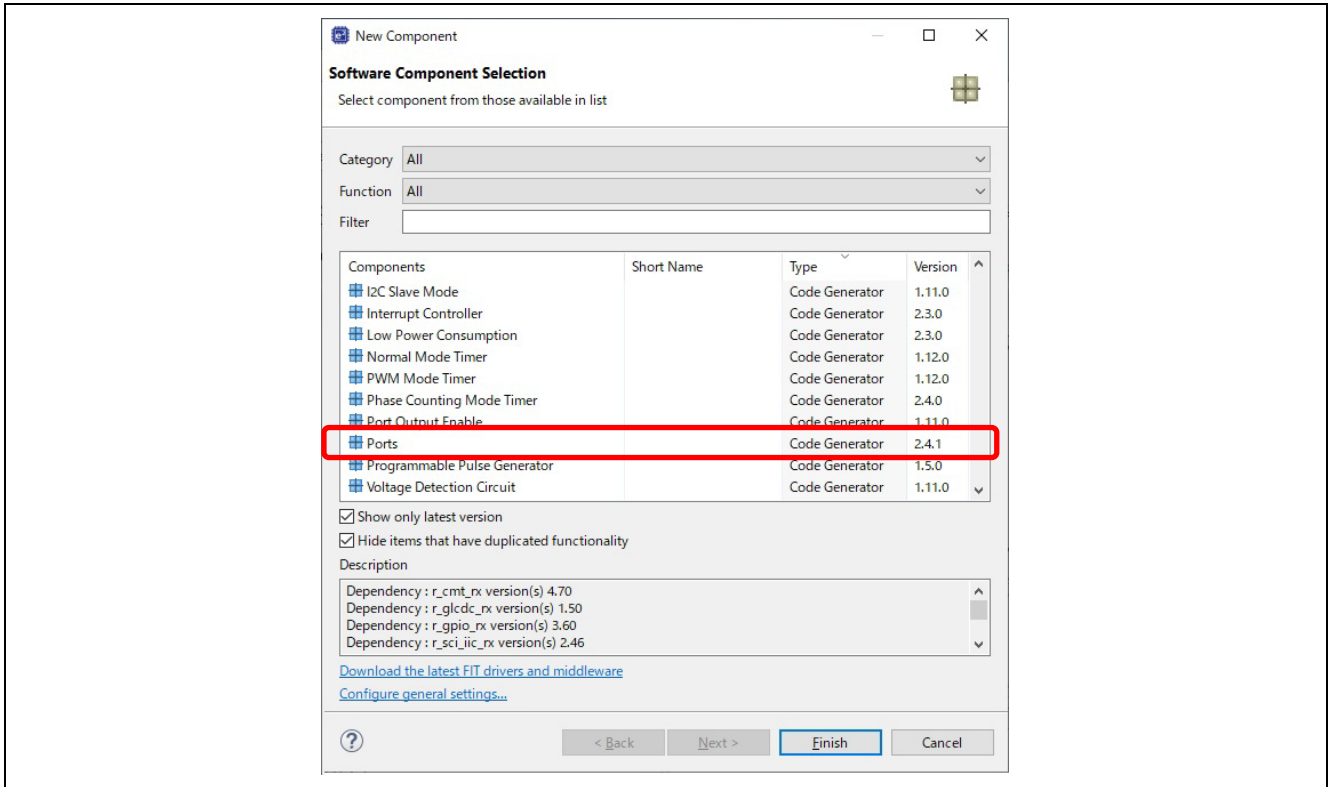


Figure 4-13 Adding "Ports"

(3) Configuring a port component

To control LED6 on the board, configure the corresponding port pin with the Smart Configurator.

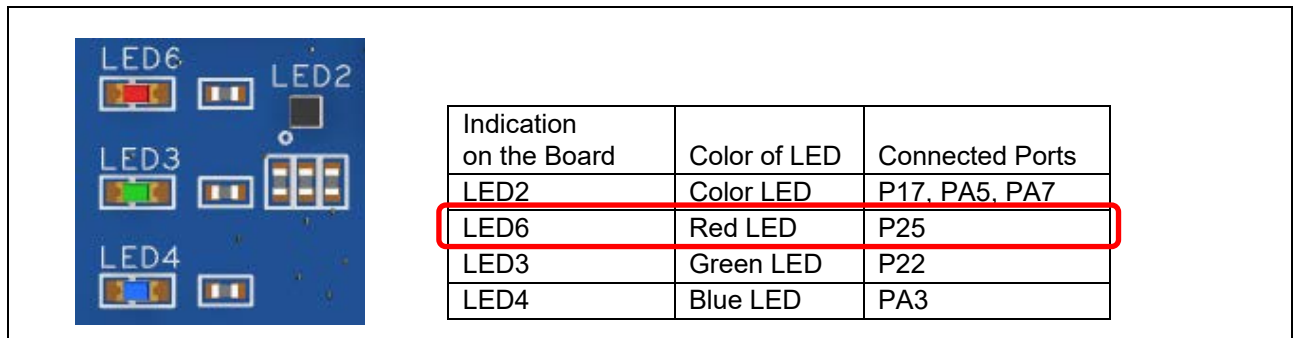


Figure 4-14 LED to be Controlled on the Board

LED6 is connected to P25.

The following diagram shows the connection of LED6 on the board. As the LED turns on when 0 is output from the port pin, the initial output value should be set to 1.

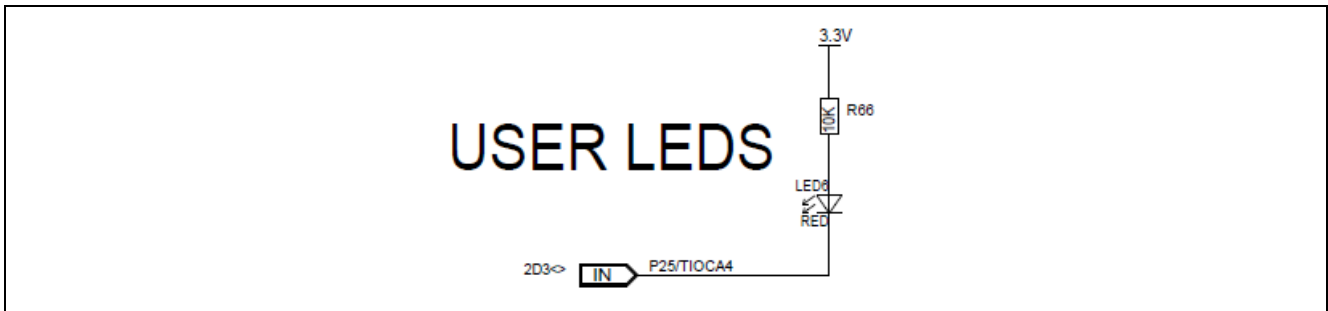


Figure 4-15 Schematic of LED6 Connection

(4) Configuring PORT2

Select the checkbox for PORT2.

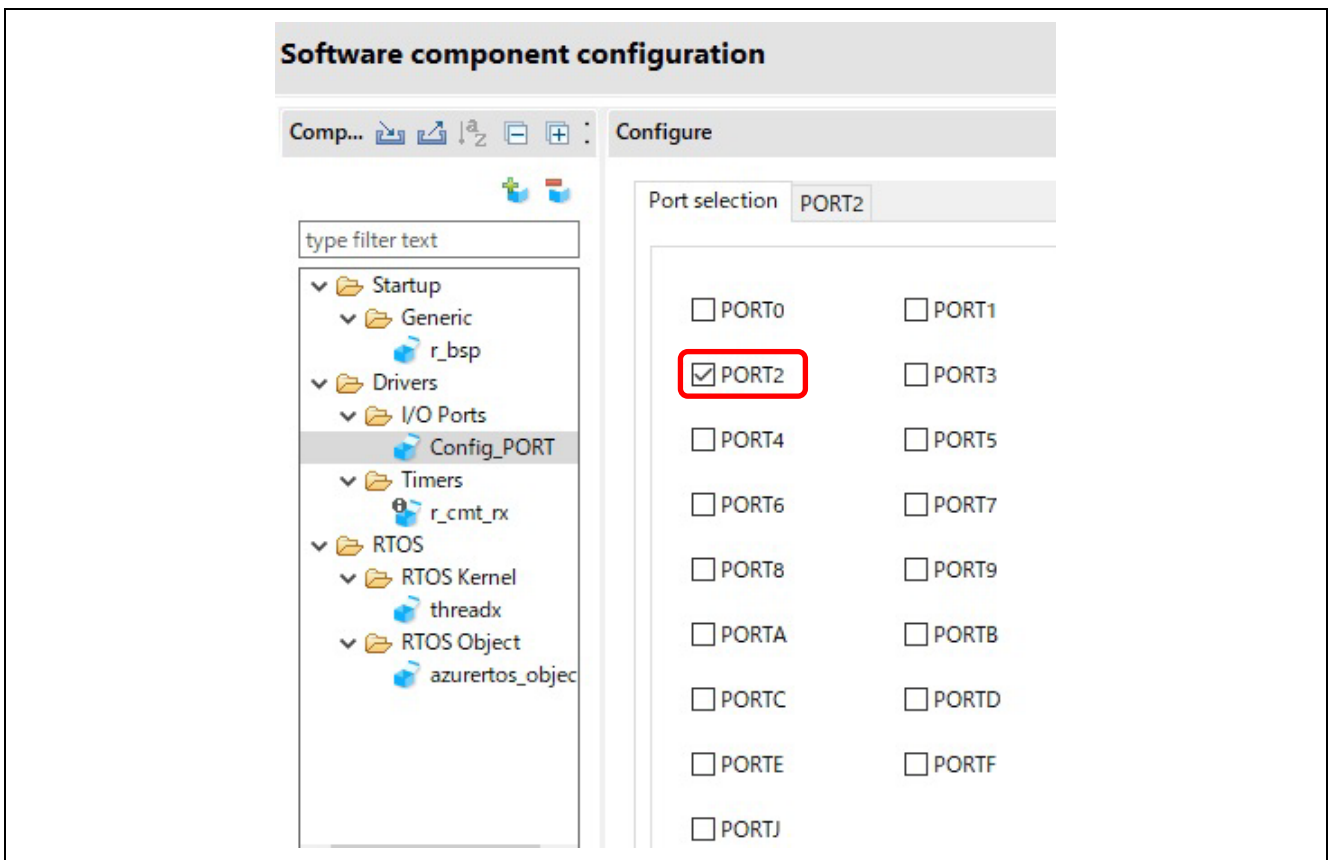


Figure 4-16 Configuring PORT2



(5) Setting P25 as an output port pin

As the LED turns on when 0 is output from the port pin, set the initial value to "Output 1".

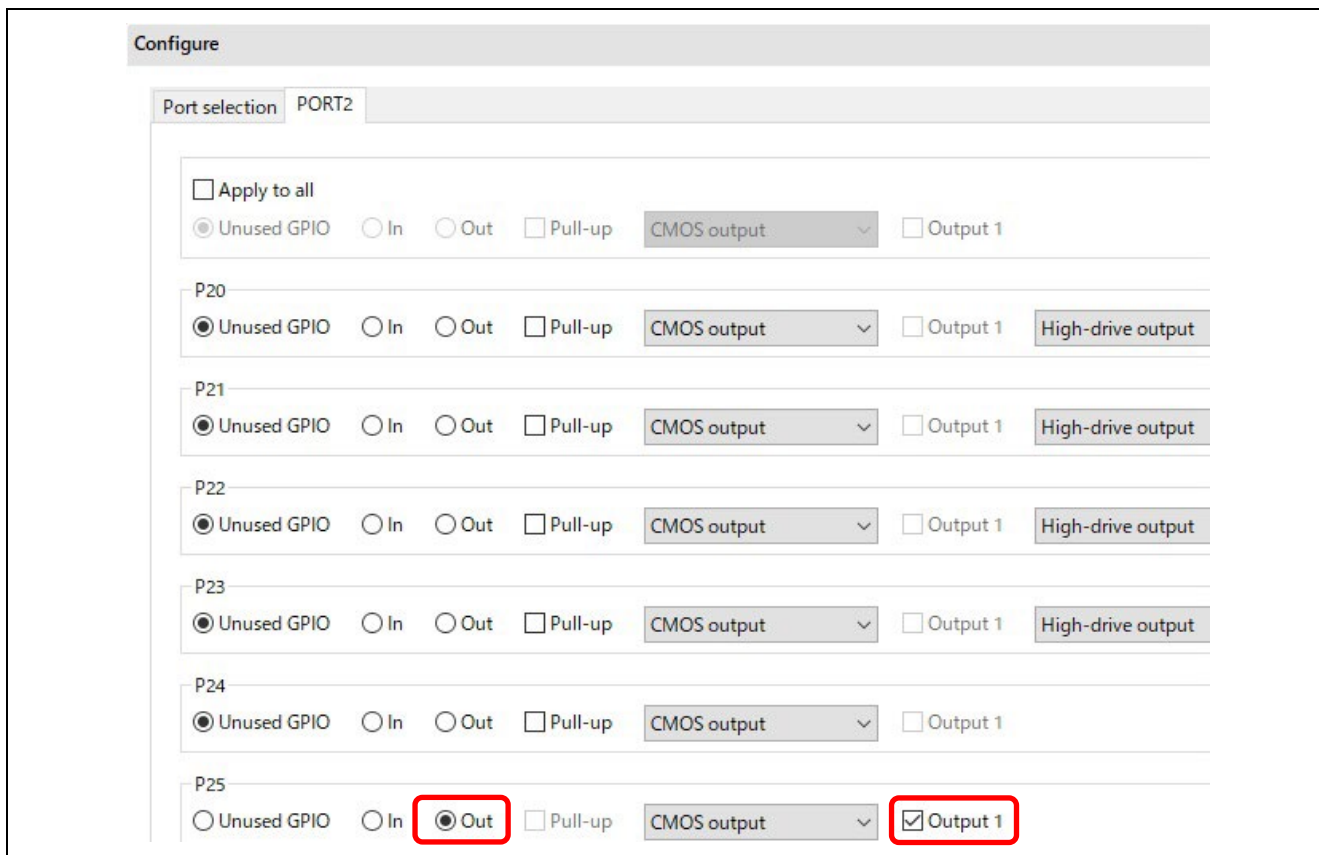


Figure 4-17 Configuring P25

4.4 Generating Source Files

Click on the [Generate Code] button to generate source files.

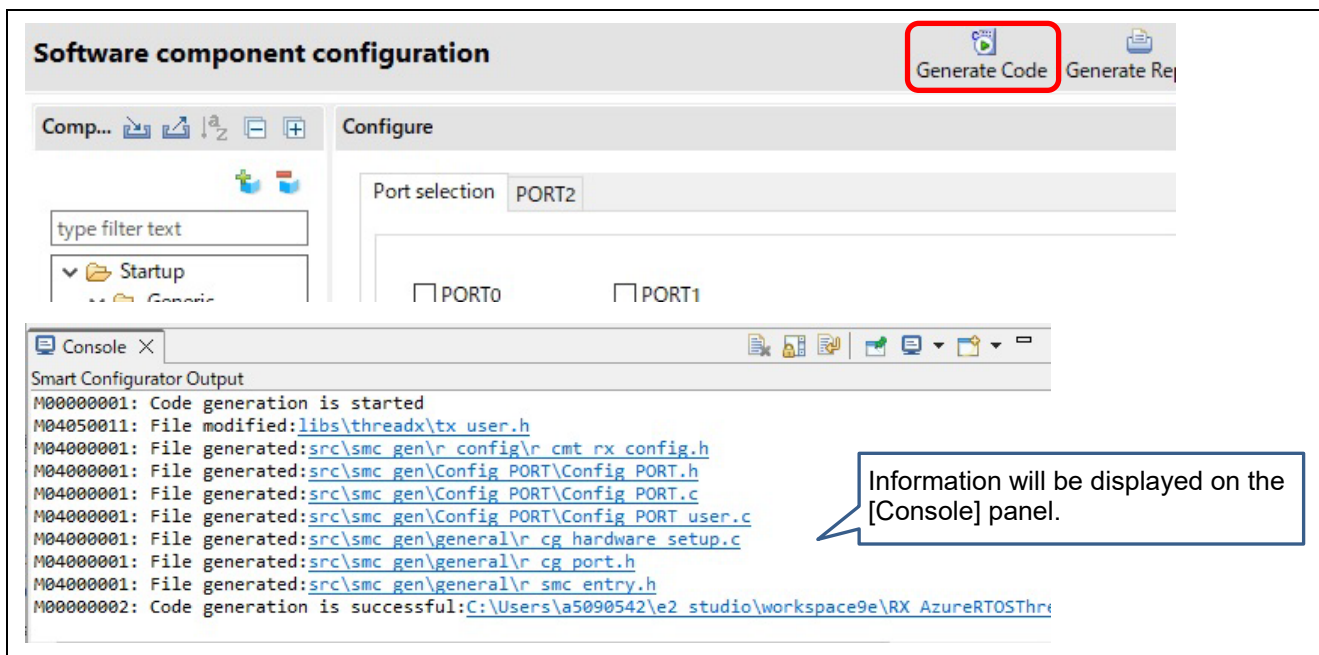


Figure 4-18 Reflecting the Configuration on Source Files



## 4.5 Editing Source Files

Open "hardware\_setup.c" in the project tree.

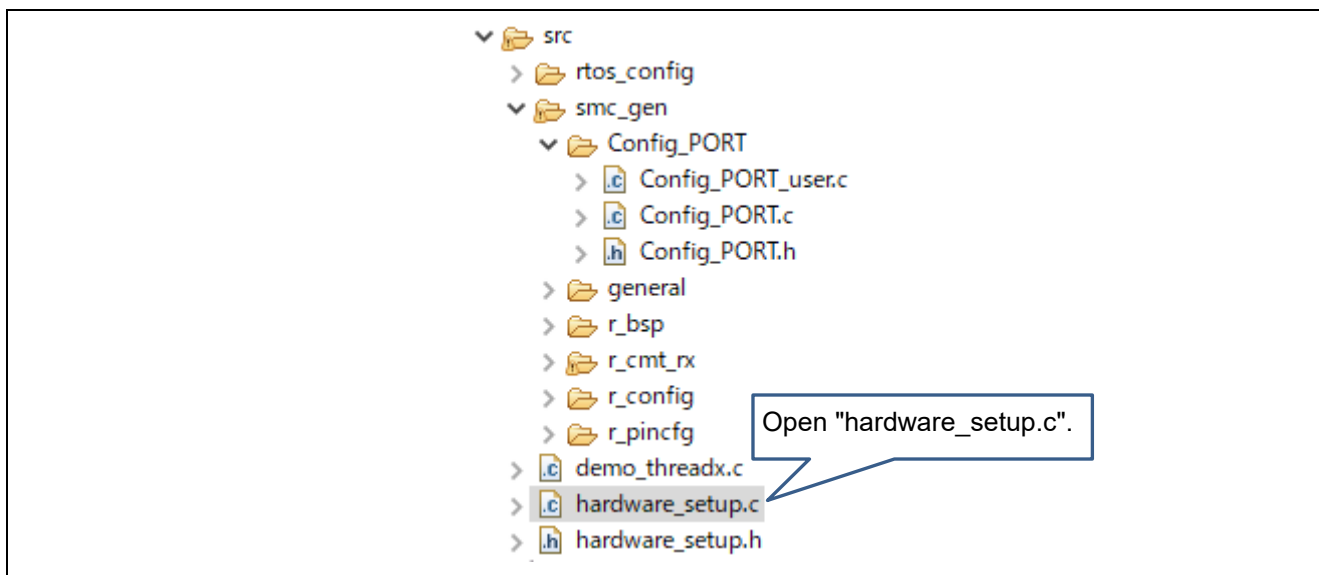


Figure 4-19 Opening a Source File in the Project Tree

Add the lines shown in red boxes below to "hardware\_setup.c".

```

#include "r_smc_entry.h"
#include <platform.h>
#include <r_cmt_rx_if.h>
#include "tx_api.h"
#include "hardware_setup.h"

```

```
volatile uint8_t gTimer;
```

```
void _tx_timer_interrupt(void);
```

```
/* CMT Timer callback used as the system tick. */
```

```
void timer_callback(void *pdata)
```

```
{
```

```
    tx timer interrupt();
```

```
    gTimer ^= 1;
```

```
    PORT2.PODR.BYTE = gTimer * 0x20;
```

```
}
```

```
void platform_setup(void)
```

```
{
```

```
    uint32_t chan;
```

```
    /* Create periodic timer for the system tick. */
```

```
    R_CMT_CreatePeriodic(TX_TIMER_TICKS_PER_SECOND, timer_callback, &chan);
```

```
}
```

Repeat switching of the gTimer value between 0 and 1 in the timer interrupt handler processing. This turns the LED connected to P25 on and off.

Edit "tx\_api.h".

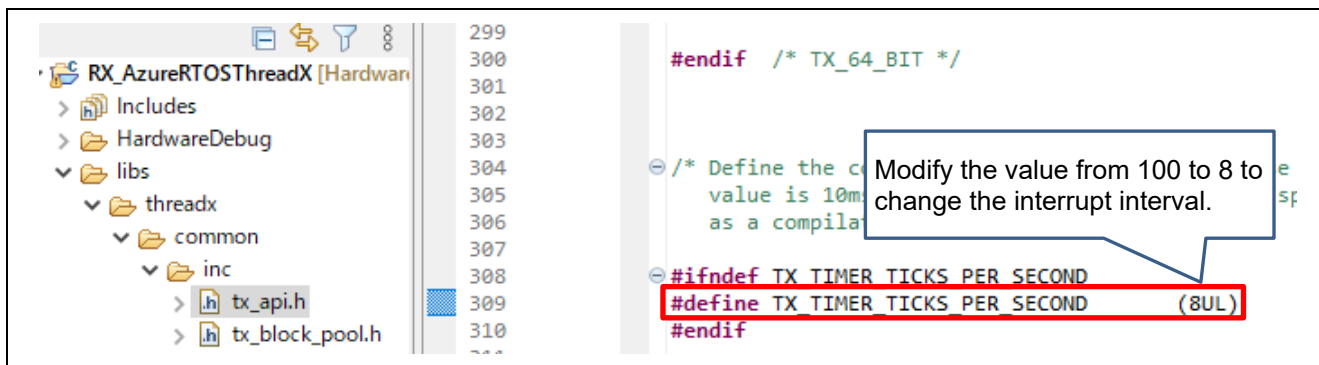


Figure 4-20 Target File and Content of Editing

### 4.6 Building the Project

Build the project.

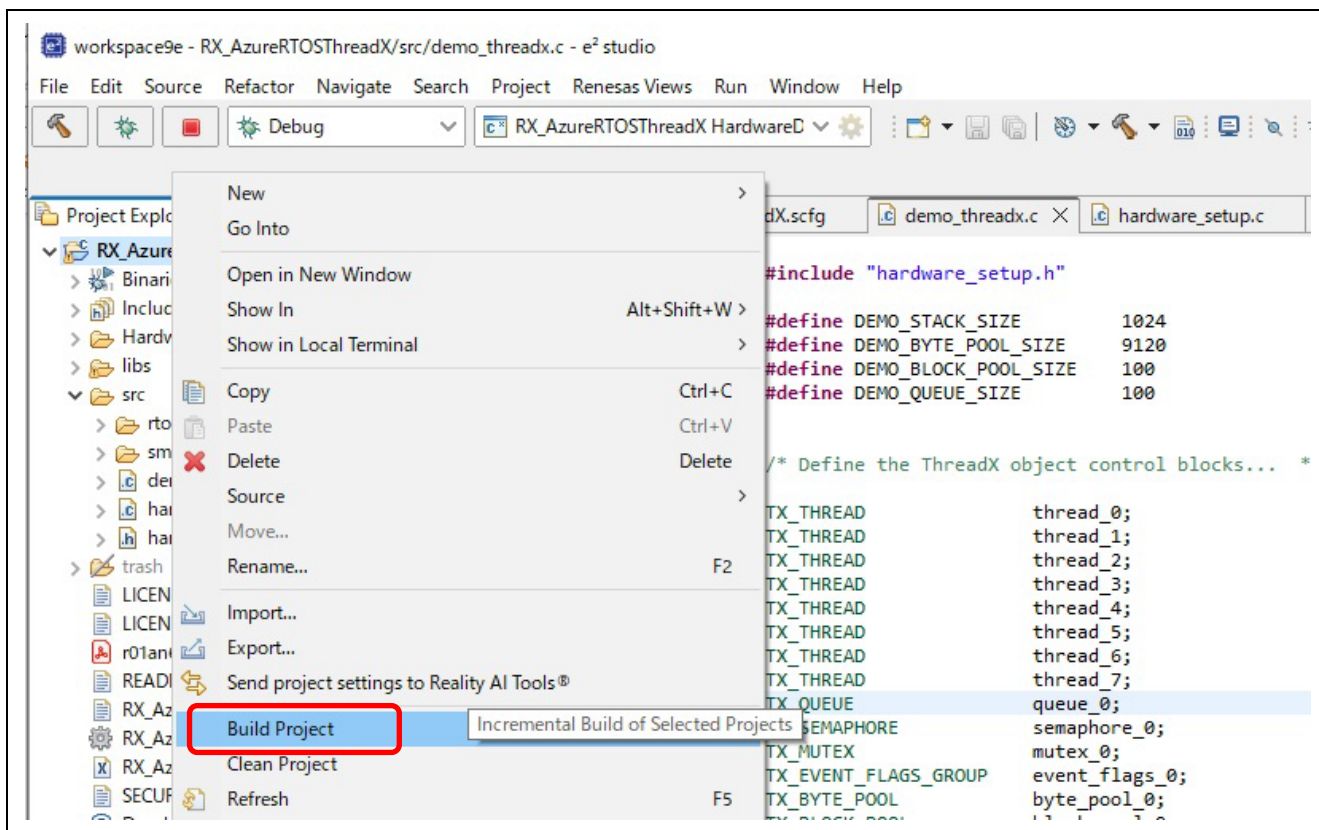


Figure 4-21 Building the Project

On completion of the build process, check that no errors have occurred.

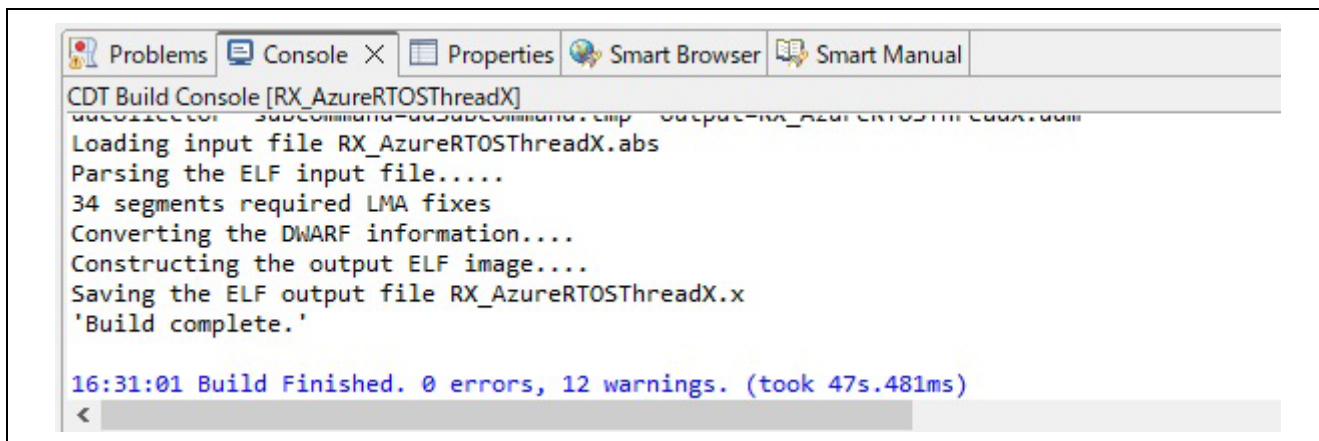


Figure 4-22 Results of Building

### 4.7 Executing the Project

Select a debug configuration and click on [Debug] to download and execute the program.

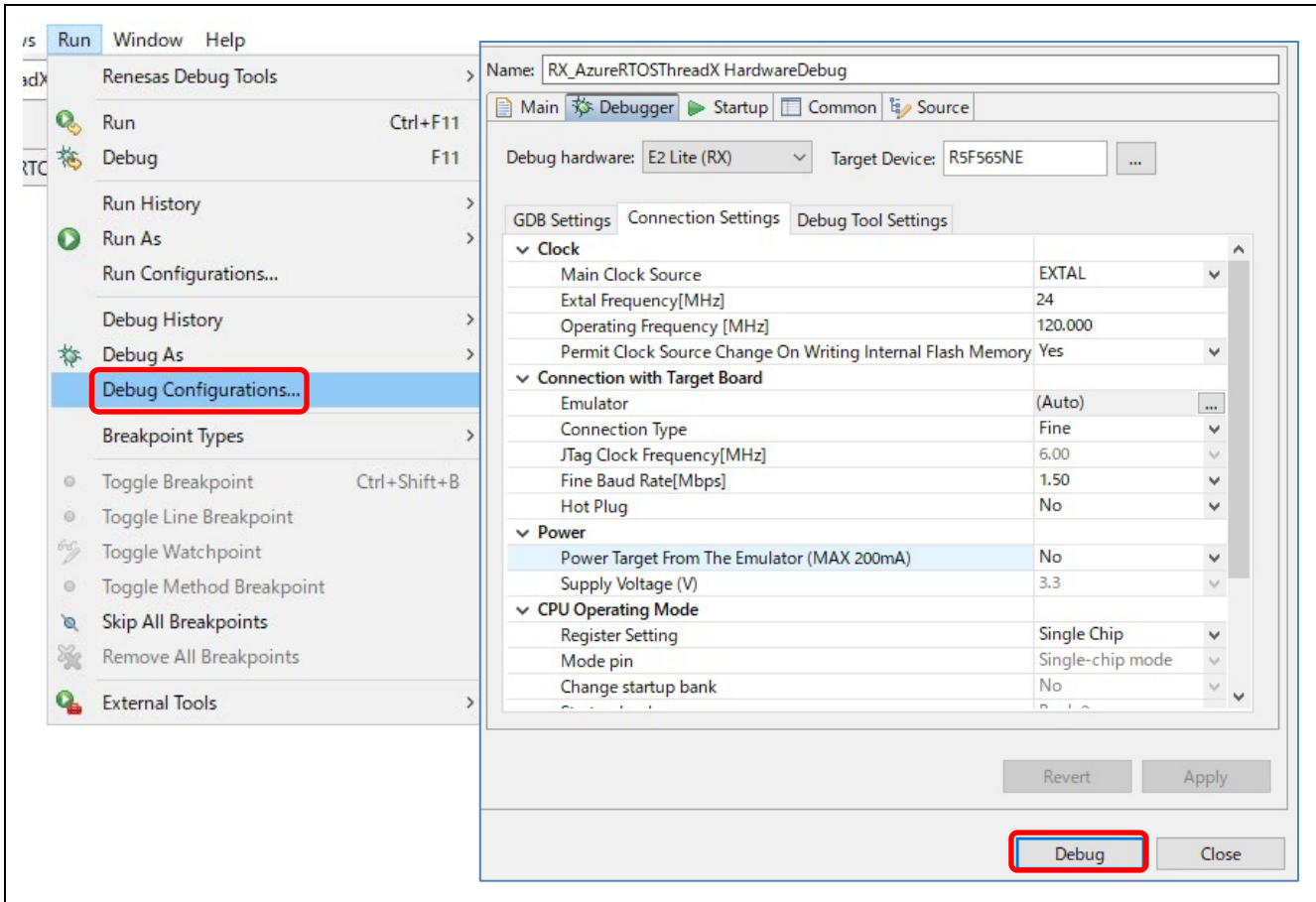


Figure 4-23 Selecting a Debug Configuration and Executing the Program



Figure 4-24 Appearance of the Board during Execution



### 5. Sample Project

The sample file "demo\_threadx.c" contains a standard ThreadX project, which has eight threads.

This sample project file illustrates how to use major services of ThreadX such as threads, a message queue, a timer, a semaphore, a byte memory pool, a block memory pool, an event flag group, and a mutex.

Select [Window] → [Show View] → [Outline] in the e<sup>2</sup> studio.

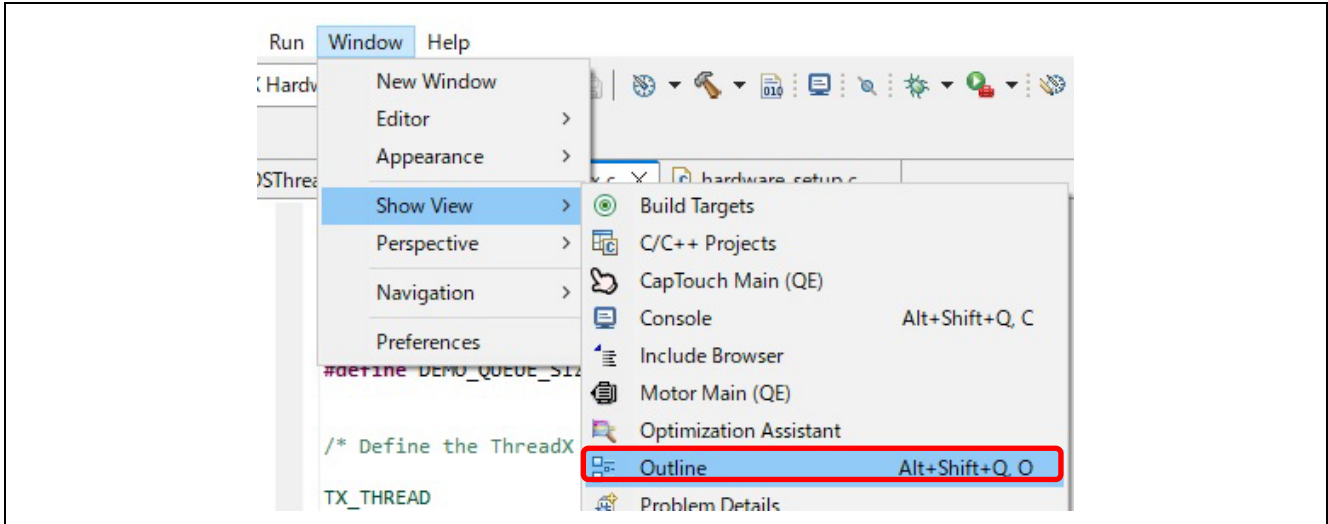


Figure 5-1 Selecting [Outline]

Select a thread in the outline view for "demo\_threadx.c" and the display will jump to the function of the selected thread.

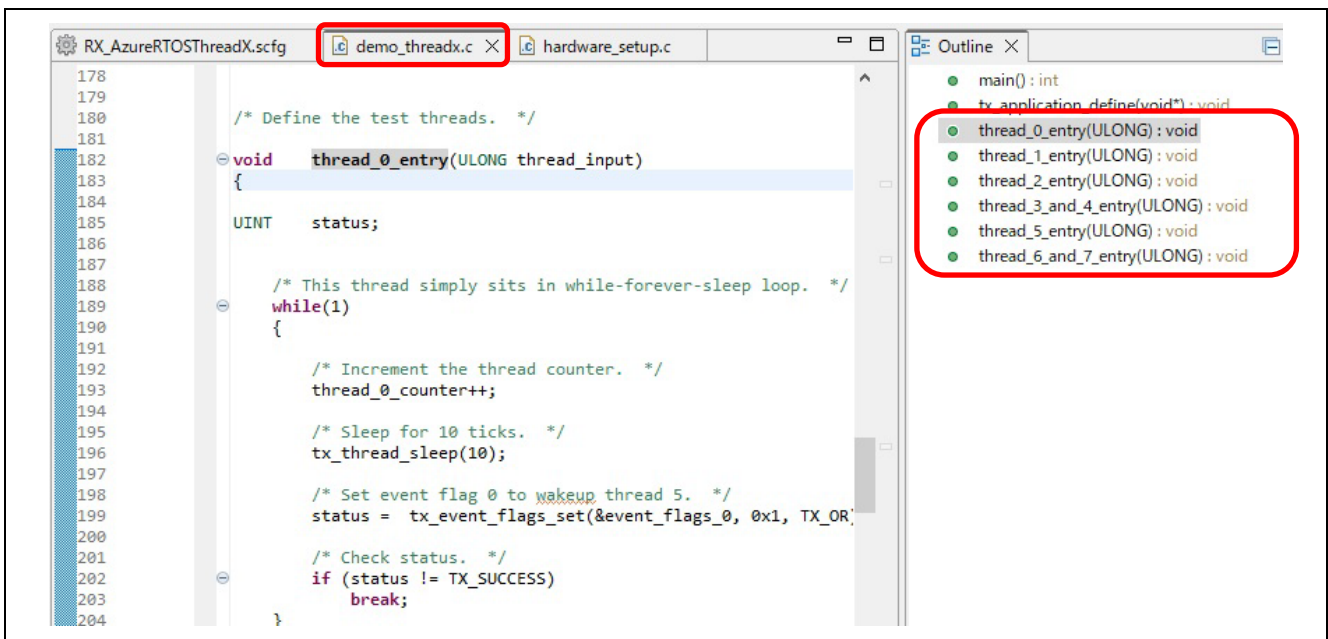


Figure 5-2 A Thread Displayed in the Outline View

The comment at the beginning of each function is a summary of the processing by the thread. The summaries in the list below have been slightly modified for clarity from the summary comments in the code.

**Table 5-1 Summary of the Threads in the Sample Project**

<b>Thread Number</b>	<b>Processing by the Thread</b>
0	This thread simply sits in a while-forever-sleep loop.
1	This thread simply sends messages to a queue shared with thread 2.
2	This thread retrieves messages placed on the queue by thread 1.
3	This function is executed as both thread 3 and thread 4. As can be seen from the loop in the code, the threads run as this function alternate between ownership of semaphore_0.
4	
5	This thread simply waits for an event in an endless loop.
6	This function is executed as both thread 6 and thread 7. As can be seen from the loop in the code, the threads run as this function alternate between ownership of mutex_0.
7	



## 6. Setting the Trace Buffer for Use by TraceX

Azure RTOS TraceX displays the system event information collected by ThreadX that is being executed on the target embedded system.

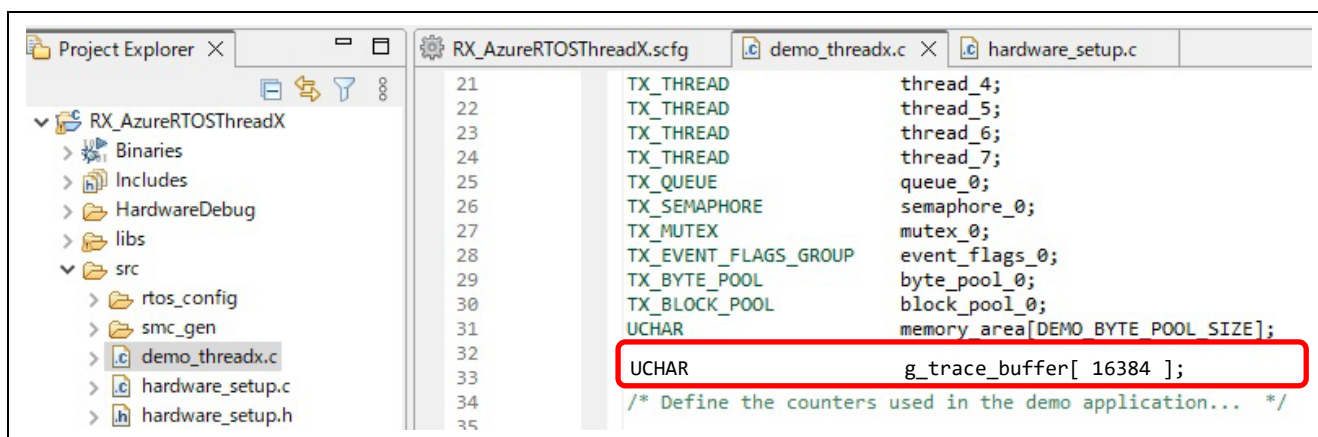
Enabling analysis by TraceX requires that the program specify a trace buffer for use in analysis.

Use the following API function.

```
tx_trace_enable (VOID *trace_buffer_start, ULONG trace_buffer_size, ULONG registry_entries);
```

This API function enables event tracing in ThreadX. The application is required to specify the size of the trace buffer and the maximum number of ThreadX objects.

Open "demo\_threadx.c" and add the following global variable.



**Figure 6-1 Adding a Global Variable**

In addition, add the following API function to the tx\_application\_define function in "demo\_threadx.c".

```

void tx_application_define(void *first_unused_memory)
{
    CHAR *pointer = TX_NULL;

    _tx_trace_enable( &g_trace_buffer, 16384, 30 );
}

```

**Figure 6-2 Adding an API Function**

- Notes:
1. The buffer size is set to 16384 in this example, but it can be set to a greater value such as 32768 if the RAM of the MCU has enough unused space.
  2. Build the project again after the global variable and API function have been added to "demo\_threadx.c".

For details, refer to the following page on the Microsoft educational site:

[Chapter 5 - Generating trace buffers | Microsoft Learn](#)

## 7. Using the [RTOS Resources] View

The e<sup>2</sup> studio has an RTOS resource view function that displays the state of Azure RTOS ThreadX resources. The following is a description of the procedure for using the [RTOS Resources] view.

### 7.1 Displaying the [RTOS Resources] View

The [RTOS Resources] view is only available while the debugger is running. Start the debugger and then select [Renesas Views] → [Partner OS] → [RTOS Resources]. After the [Select OS] dialog box is displayed, select "ThreadX" as shown in Figure 7-2. The [RTOS Resources] view will appear as shown in the figure.

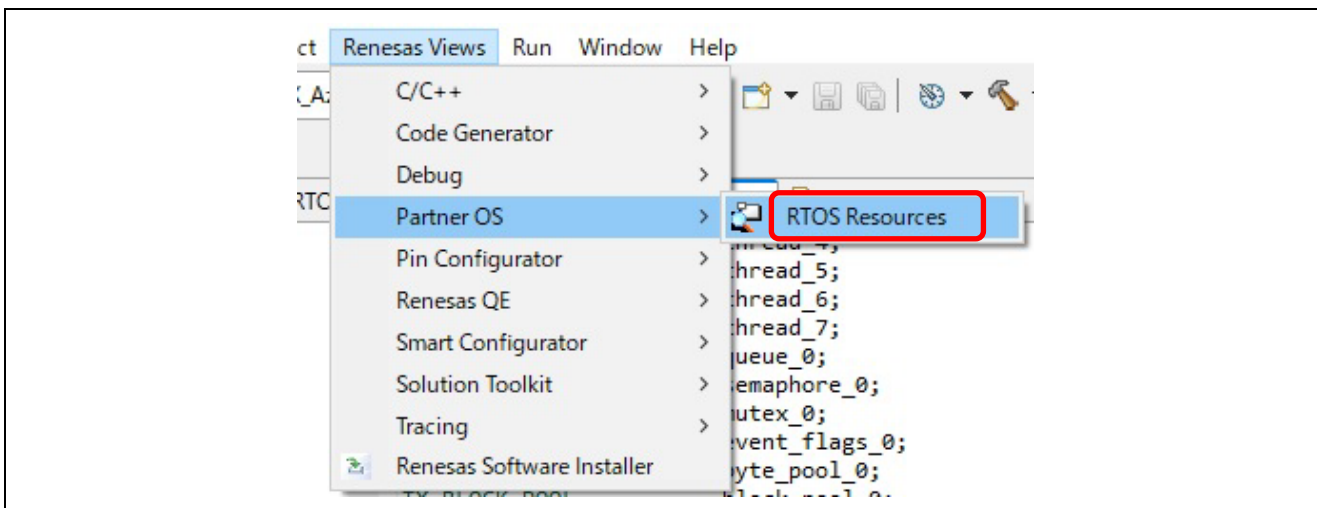


Figure 7-1 Selecting [RTOS Resources]

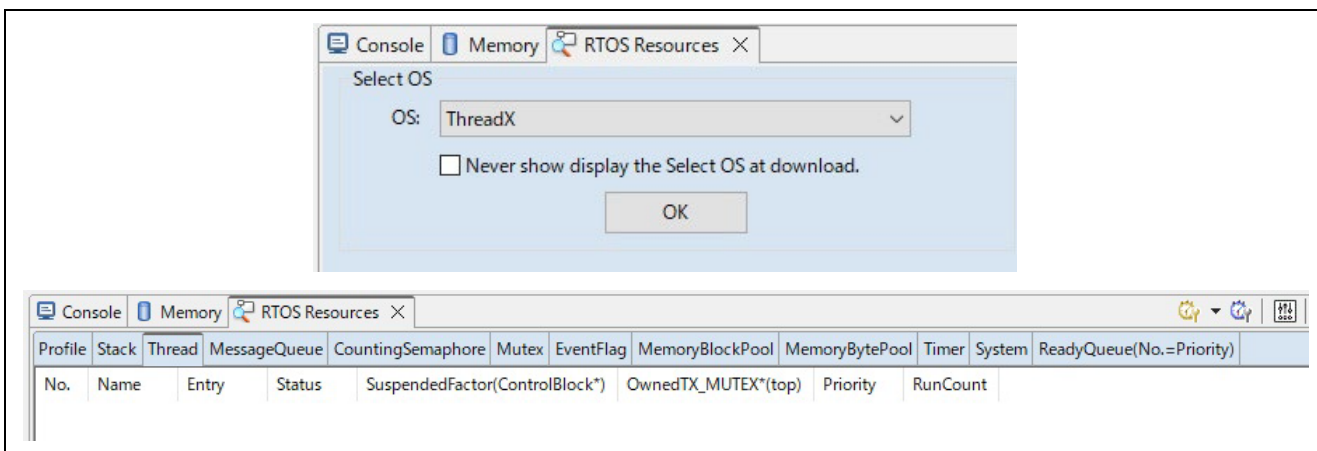


Figure 7-2 Selecting the OS and Displaying the [RTOS Resources] View

## 7.2 Context Menu

Display the context menu by right-clicking on the mouse with the cursor in the [RTOS Resources] view.

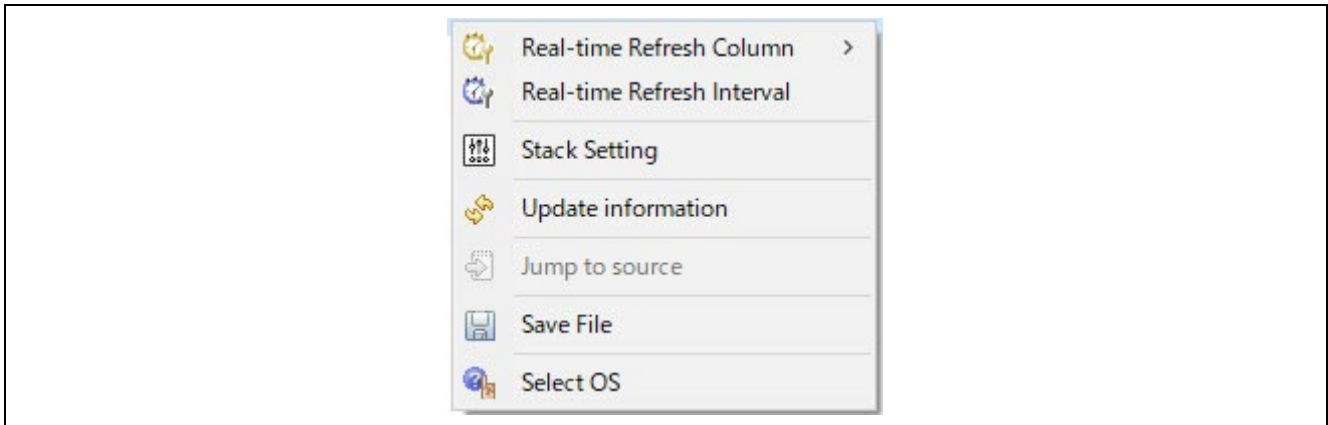


Figure 7-3 Context Menu

- **Real-time Refresh Column:**  
Enables or disables real-time updating of information displayed in the individual columns (tabbed pages). This is grayed out and not selectable while the program is running.
- **Real-time Refresh Interval:**  
Specifies the interval for real-time updating of the display. The specifiable values are in the range from 500 ms to 10000 ms. This is grayed out and not selectable while the program is running.
- **Stack Setting:**  
Enables or disables loading of the stack data and specifies the threshold for the stack warning function. This is grayed out and not selectable while the program is running.
- **Update information:**  
Updates the displayed information.
- **Jump to source:**  
Opens an editor view displaying the source code of the task/thread or handler. Double-clicking on a task/thread or a handler also opens an editor view. This is grayed out and not selectable while the program is running.
- **Save File:**  
Saves the data on the currently selected tabbed page in a text file (\*.txt). This is grayed out and not selectable while the program is running.
- **Select OS:**  
Opens the [Select OS] dialog box. This is grayed out and not selectable while the program is running.

### 7.3 Stack Setting

This is for enabling the loading of stack data and setting the stack threshold.

- Open the context menu and select [Stack Setting].
- To load stack data to the [RTOS Resources] view, check the [Enable loading Stack data] checkbox in the [Stack Setting] dialog box. If this option is not enabled, stack data will not be loaded in the next debugging session.
- A desired threshold value can be set in the [Stack Threshold (%)] textbox. Click on [OK] to save the setting. The value is set to 80% in this example.

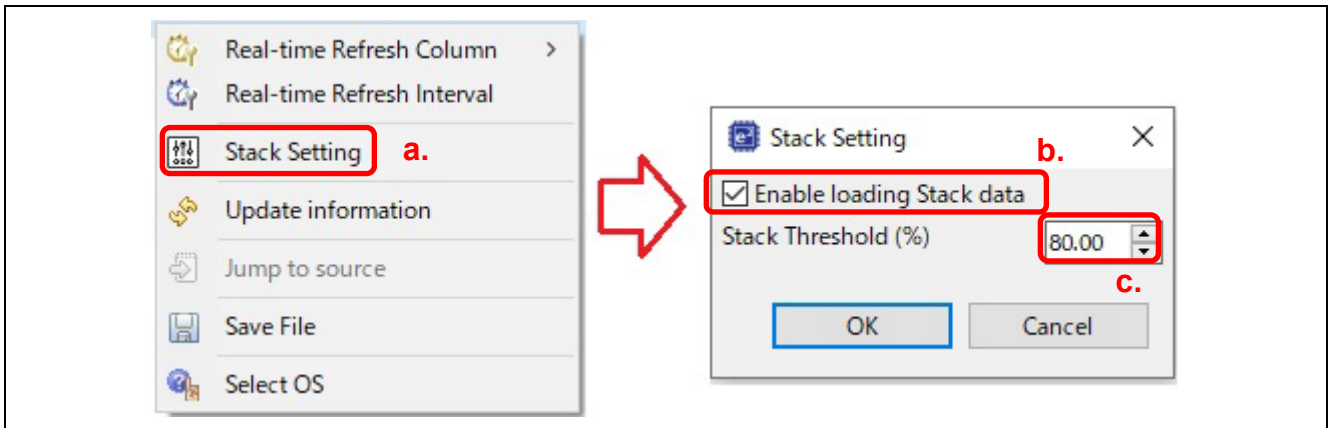


Figure 7-4 Settings for the Stack

### 7.4 Tabbed Pages

Table 7-1 lists the items displayed on the individual tabbed pages.

**Table 7-1 Contents of Individual Tabbed Pages**

Name of the Tabbed Page in the [RTOS Resources] View	Name of Displayed Information and Selection	Information to be Displayed
Profile	The facilities of the [Profile] tabbed page are not currently available.	—
Stack	Name	Names of the threads
	Entry	Function that started each thread
	StackPointer	Current stack pointer
	StackStart	Address of the beginning of the stack
	StackEnd	Address of the end of the stack
	StackSize(bytes)	Stack size
	MaxStackUsage(bytes)	Maximum amount of stack currently in use
Thread	Name	Names of the threads
	Entry	Function that started the given thread
	Status	State of each thread
	Suspended Factor (Control Block*)	Resource that is the source of suspension
	OwnedTX_MUTEX*(top)	Top acquired mutex
	Priority	Priority
	RunCount	Number of times the thread has been executed
MessageQueue	Name	Names of the message queues
	UsedCount	Number of message queues in use
	FreeCount	Number of available message queues
	TotalCount	Total number of message queues
	MessageSize	Message size
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads
	StartAddress	Address where the message queue starts
	EndAddress	Address where the message queue ends
CountingSemaphore	Name	Names of the semaphores
	SemaphoreCount	Number of semaphores
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads
Mutex	Name	Names of the mutexes
	OwnerTX_THREAD*	Acquiring thread
	OwnerCount	Number of owners
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads
EventFlag	Name	Names of the event flags
	Flag	Current flag pattern
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads

MemoryBlockPool	Name	Names of the memory blocks
	FreeCount	Number of available blocks
	TotalCount	Total number of blocks
	BlockSize(bytes)	Block size
	TotalSize(bytes)	Total size of memory block pools
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads
	StartAddress	Top address of a memory block pool
MemoryBytePool	Name	Names of the memory pools
	Free(bytes)	Number of available bytes
	Total(bytes)	Total size of memory byte pools
	FragmentCount	Number of fragments
	SuspendedTX_THREAD*(top)	Top waiting thread in the queue
	SuspendedCount	Number of suspended threads
	StartAddress	Address where the memory byte pool starts
Timer	Name	Names of the timers
	Remaining Tick	Remaining time in ticks
	Re-initialization Tick	Cycle time in ticks
System	SystemClock	System clock
ReadyQueue(No. = Priority)	QueuedTX_THREAD*(top)	Top ready thread



## 8. Starting Debugging of a Project with Azure RTOS TraceX

Select the [Run] menu → [Debug] to launch the debugger.

Create a data file for Azure RTOS TraceX by following the procedure below.

### 8.1 Acquiring the Address of the TraceX Data Buffer

Use the [Add Watch Expression] menu to add “g\_trace\_buffer” in “demo\_threadx.c” to the expressions to be watched and acquire the address of the data buffer for Azure RTOS TraceX. The address is “0x736c” in the following example.

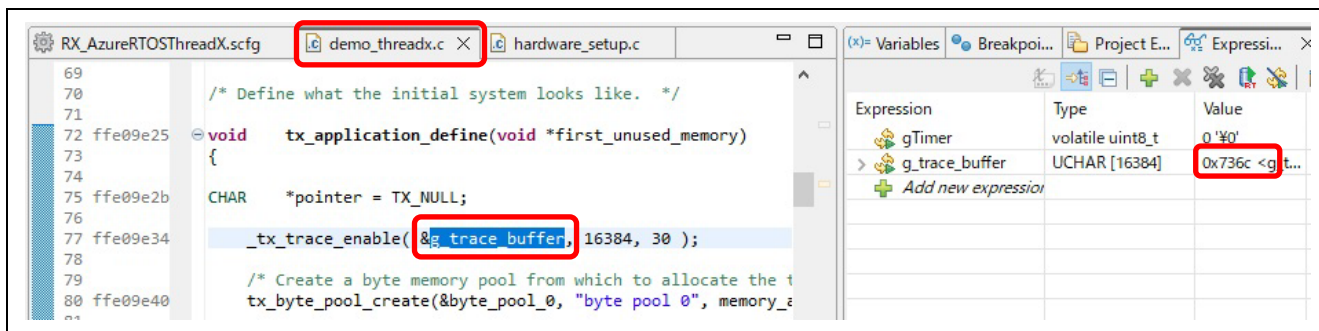


Figure 8-1 Acquiring the Address of the Data Buffer

### 8.2 Exporting a Data File for TraceX

Export a data file for TraceX by following the procedure below.

Execute the program with the  button and then stop it with the  button.

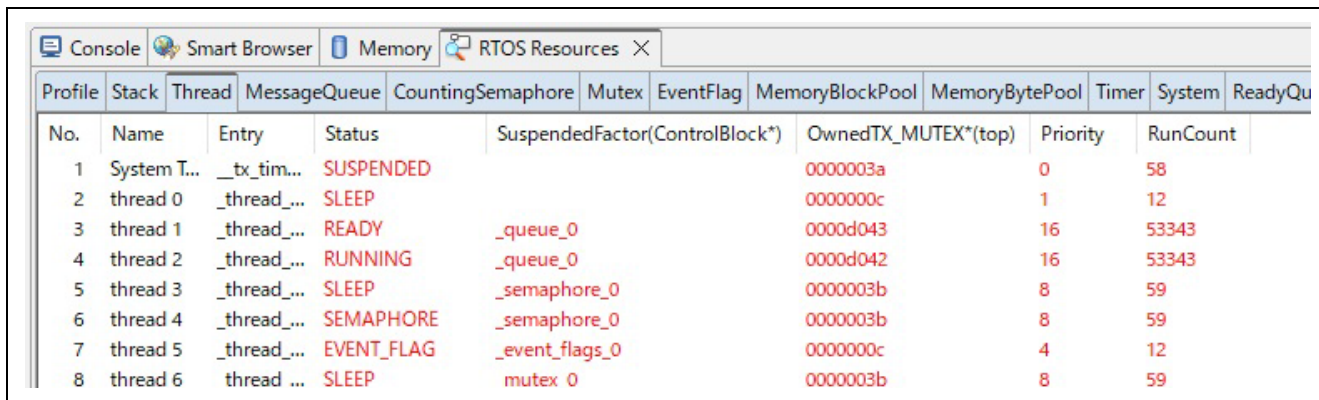


Figure 8-2 Information Displayed on the [Thread] Tabbed Page

- a. Select [Window] → [Show View] → [Memory].
- b. Open the [Monitor Memory] dialog box and enter the address of the data buffer for Azure RTOS TraceX that was acquired in section 8.1.

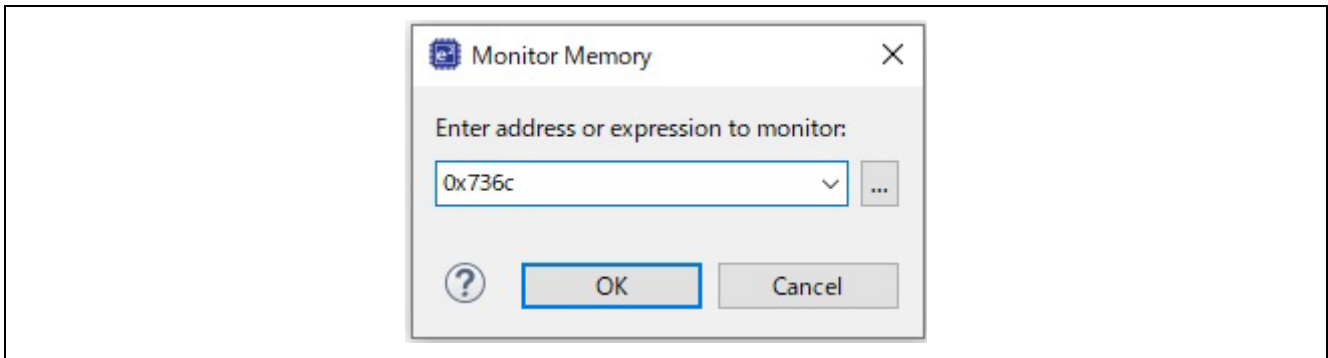


Figure 8-3 Entering the Address for Monitoring

- c. Press the [Export] button to the right of the [Memory] tab.
- d. The [Export Memory] dialog box will pop up.
- e. For [Format], select "RAW Binary".
- f. For [Start address], enter the address of the TraceX data buffer that was acquired in section 8.1.
- g. For [Length], enter 16384\* as the size of the TraceX data buffer, "g\_trace\_buffer".
- h. For [File name], create a desired file name with the extension ".trx".
- i. Press [OK]. The data file for TraceX is then exported with the file name specified in (h).

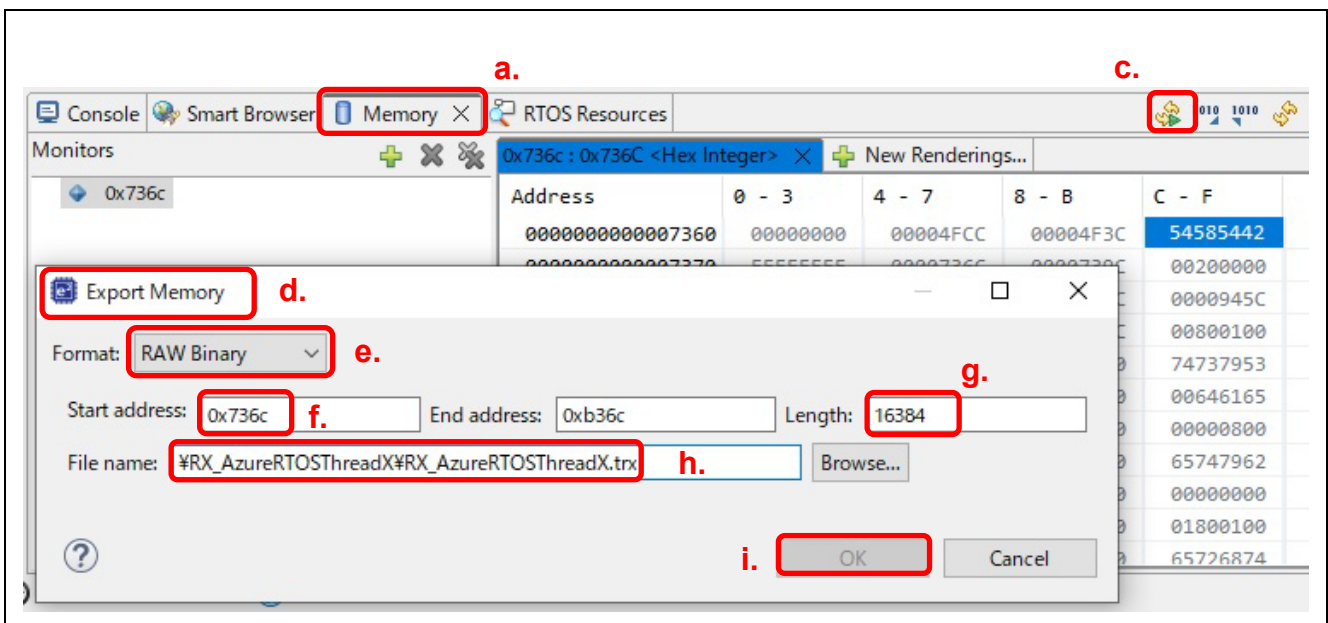


Figure 8-4 Exporting a Data File

Note: \* Enter the size specified in section 6, Setting the Trace Buffer for Use by TraceX.

## 9. Launching Azure RTOS TraceX

Launch Azure RTOS TraceX that has been installed on the host PC.

Click on the [File] menu → [Open] for Azure RTOS TraceX.

Select the TraceX data file "\*\*\*\*.trx" exported according to the steps in section 8.2.

Trace information will be shown in TraceX.

### 9.1 Display of Trace Information

Trace information can be displayed in either of the following two ways.

- Sequential view mode
- Time view mode

#### 9.1.1 Sequential View Mode

The sequential view shows events immediately followed by others without regard to the elapsed times between events. This mode is useful to get an overview of the system operation.

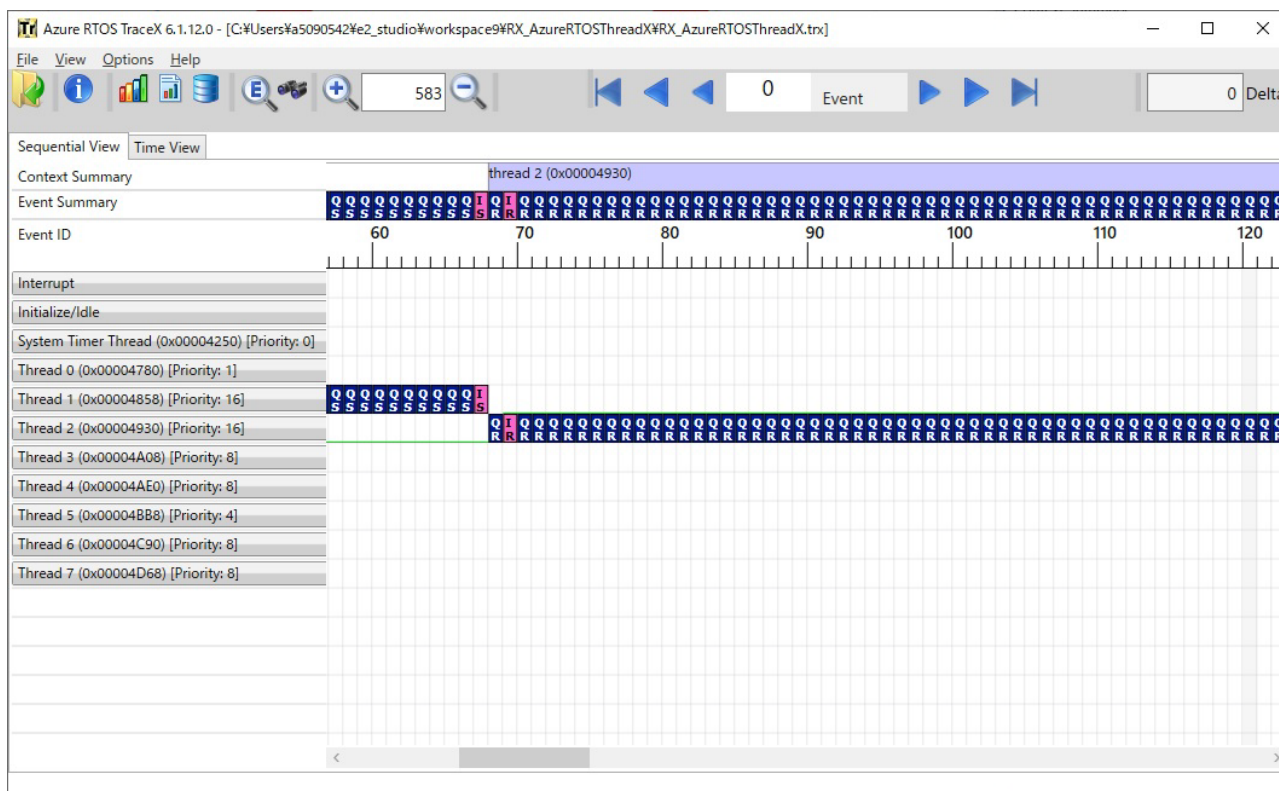


Figure 9-1 Display in the Sequential View

### 9.1.2 Time View Mode

This mode is useful to find the locations where the bulk of processing takes place in the system and can help the user to tune the system for better performance or responsiveness.

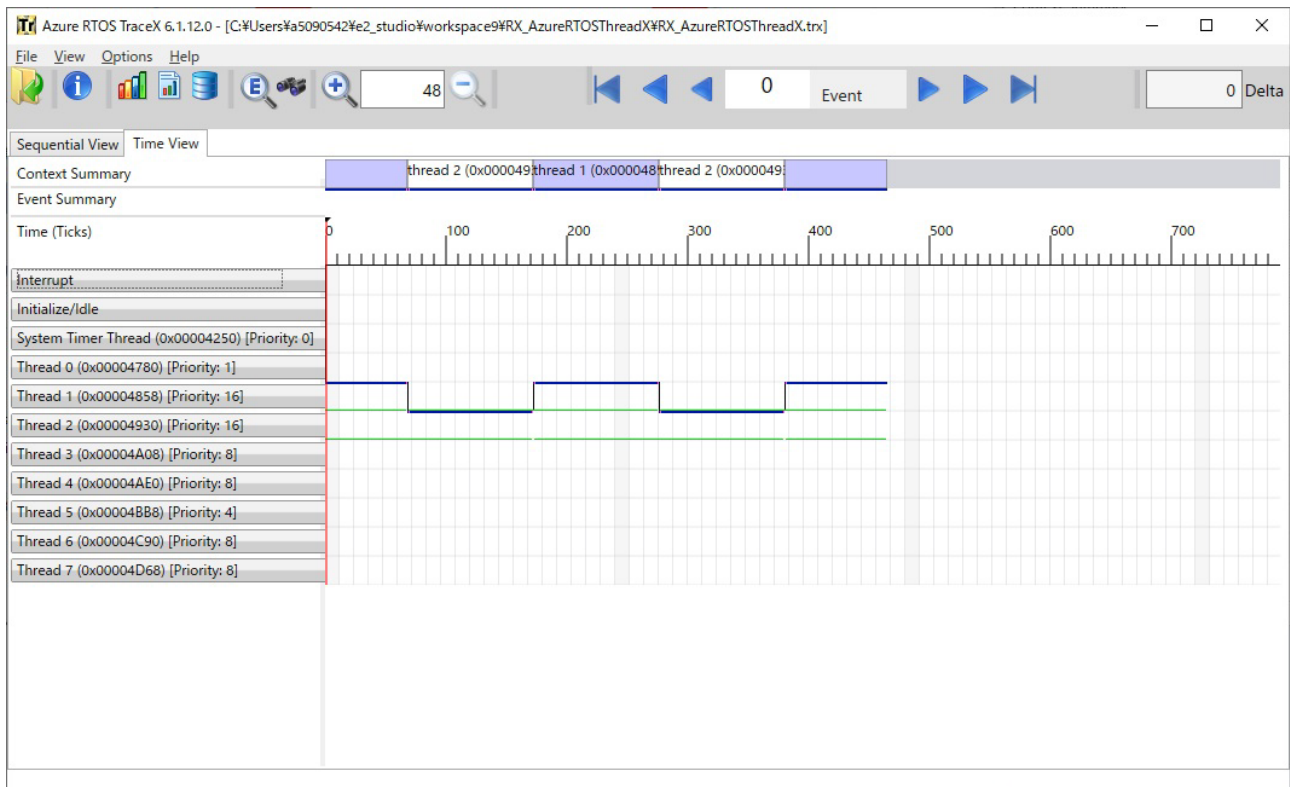


Figure 9-2 Display in the Time View

## 9.2 Analysis Facilities of TraceX

For details of the analysis facilities, see [Help] → [Manual].

Refer to the following descriptions in "[Chapter 3 – Description of Azure RTOS TraceX](#)" of the *TraceX User Guide* | Microsoft Docs.

- Sequential View Mode
- Time View Mode

Also refer to the following descriptions in "[Chapter 4 - Azure RTOS TraceX performance analysis](#)" of the *TraceX User Guide* | Microsoft Docs.

- Execution Profile
- Popular Services
- Thread Stack Usage
- Performance Statistics
- FileX Statistics
- NetX Statistics
- Trace File Information

**Website and Support**

Visit the following URLs to learn about key elements of the RX family, download components, and related documentation, and get support.

RX Family Product Information	<a href="http://www.renesas.com/rx">www.renesas.com/rx</a>
RX Family Product Support Forum	<a href="http://www.renesas.com/rx/forum">www.renesas.com/rx/forum</a>
Renesas Support	<a href="http://www.renesas.com/support">www.renesas.com/support</a>

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Mar. 01, 2023	—	First edition issued

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.



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